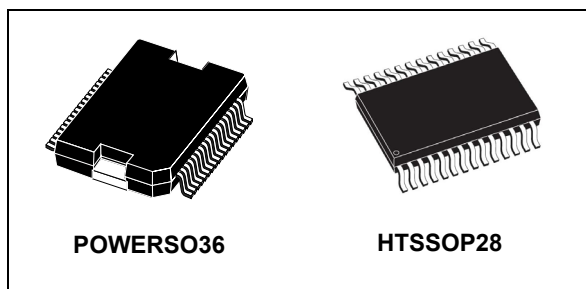


# Fully integrated microstepping motor driver

Datasheet - production data



## Features

- Operating voltage: 8 - 45 V
- 7.0 A output peak current (3.0 A<sub>r.m.s.</sub>)
- Low  $R_{DS(on)}$  power MOSFETs
- Programmable power MOS slew rate
- Up to 1/16 microstepping
- Current control with adaptive decay
- Non-dissipative current sensing
- SPI interface
- Low quiescent and standby currents
- Programmable non-dissipative overcurrent protection on all power MOS
- Two-level overtemperature protection

## Applications

- Bipolar stepper motor

## Description

The L6474 device, realized in analog mixed signal technology, integrates a dual low  $R_{DS(on)}$  DMOS full bridge with all power switches equipped with an accurate on-chip current sensing circuitry suitable for non-dissipative current control and overcurrent protections. Thanks to a new current control, a 1/16 microstepping is achieved through an adaptive decay mode which outperforms traditional implementations.

All data registers, including those used to set analogue values (i.e.: current control value, current protection trip point, deadtime, etc.) are sent through a standard 5 Mbit/s SPI.

A very rich set of protections (thermal, low bus voltage, overcurrent) makes the L6474 device “bullet proof” as required by the most demanding motor control applications.

**Table 1. Device summary**

| Order code | Package   | Packing       |
|------------|-----------|---------------|
| L6474H     | HTSSOP28  | Tube          |
| L6474HTR   | HTSSOP28  | Tape and reel |
| L6474PD    | POWERSO36 | Tube          |
| L6474PDTR  | POWERSO36 | Tape and reel |

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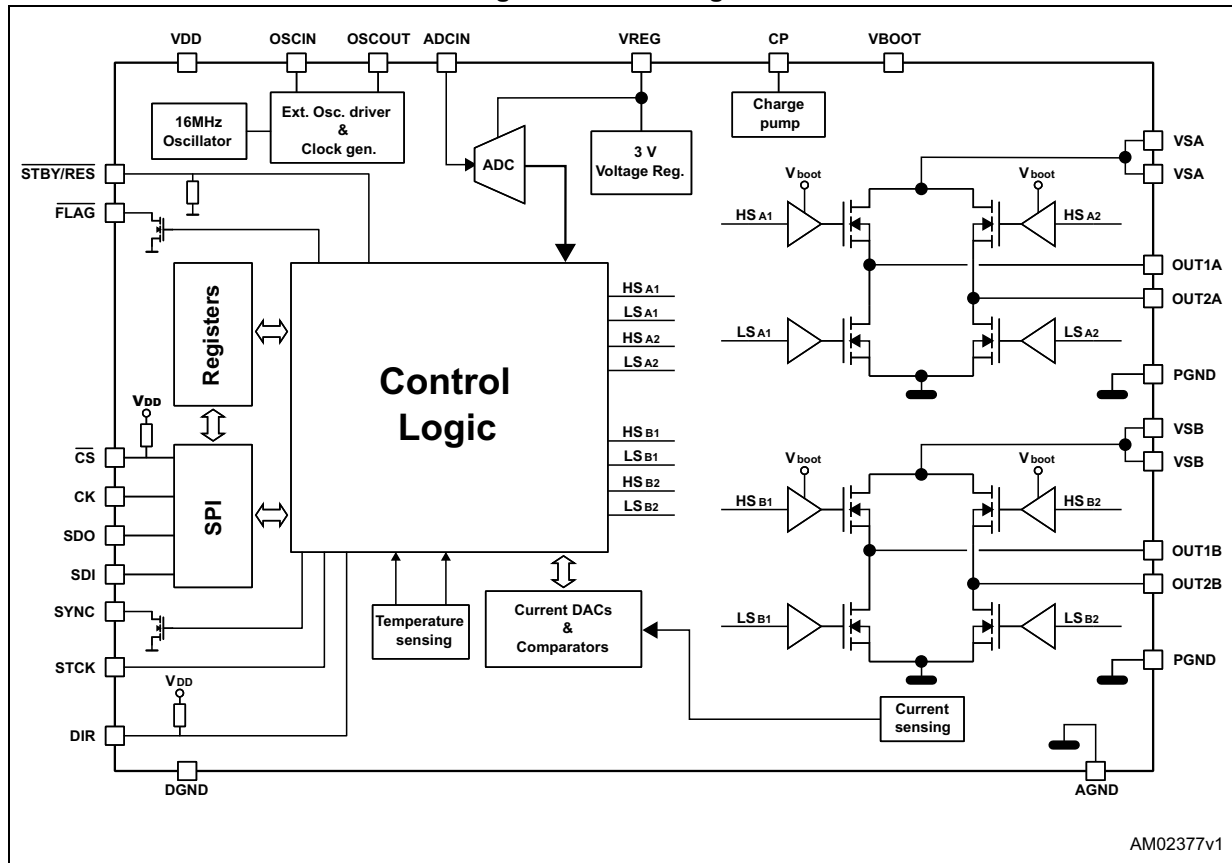
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# 1 Block diagram

Figure 1. Block diagram



## 2 Electrical data

### 2.1 Absolute maximum ratings

Table 2. Absolute maximum ratings

| Symbol                | Parameter                                                                                                                                             | Test condition            | Value        | Unit |
|-----------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------|--------------|------|
| $V_{DD}$              | Logic interface supply voltage                                                                                                                        |                           | 5.5          | V    |
| $V_S$                 | Motor supply voltage                                                                                                                                  | $V_{SA} = V_{SB} = V_S$   | 48           | V    |
| $V_{GND, diff}$       | Differential voltage between AGND, PGND and DGND                                                                                                      |                           | $\pm 0.3$    | V    |
| $V_{boot}$            | Bootstrap peak voltage                                                                                                                                |                           | 55           | V    |
| $V_{REG}$             | Internal voltage regulator output pin and logic supply voltage                                                                                        |                           | 3.6          | V    |
| $V_{ADCIN}$           | Integrated ADC input voltage range (ADCIN pin)                                                                                                        |                           | -0.3 to +3.6 | V    |
| $V_{OSC}$             | OSCIN and OSCOUT pin voltage range                                                                                                                    |                           | -0.3 to +3.6 | V    |
| $V_{out\_diff}$       | Differential voltage between $V_{SA}$ , OUT1 <sub>A</sub> , OUT2 <sub>A</sub> , PGND and $V_{SB}$ , OUT1 <sub>B</sub> , OUT2 <sub>B</sub> , PGND pins | $V_{SA} = V_{SB} = V_S$   | 48           | V    |
| $V_{LOGIC}$           | Logic inputs voltage range                                                                                                                            |                           | -0.3 to +5.5 | V    |
| $I_{out}^{(1)}$       | R.m.s. output current                                                                                                                                 |                           | 3            | A    |
| $I_{out\_peak}^{(1)}$ | Pulsed output current                                                                                                                                 | $T_{PULSE} < 1\text{ ms}$ | 7            | A    |
| $T_{OP}$              | Operating junction temperature                                                                                                                        |                           | -40 to 150   | °C   |
| $T_S$                 | Storage temperature range                                                                                                                             |                           | -55 to 150   | °C   |
| $P_{tot}$             | Total power dissipation ( $T_A = 25\text{ °C}$ )                                                                                                      | <sup>(2)</sup>            | 5            | W    |

1. Maximum output current limit is related to metal connection and bonding characteristics. Actual limit must satisfy maximum thermal dissipation constraints.
2. HTSSOP28 mounted on EVAL6474H.



## 2.2 Recommended operating conditions

Table 3. Recommended operating conditions

| Symbol                | Parameter                                                                                                                                                           | Test condition                                      | Value |     |                  | Unit |
|-----------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------|-------|-----|------------------|------|
| V <sub>DD</sub>       | Logic interface supply voltage                                                                                                                                      | 3.3 V logic outputs                                 |       | 3.3 |                  | V    |
|                       |                                                                                                                                                                     | 5 V logic outputs                                   |       | 5   |                  |      |
| V <sub>S</sub>        | Motor supply voltage                                                                                                                                                | V <sub>SA</sub> = V <sub>SB</sub> = V <sub>S</sub>  | 8     |     | 45               | V    |
| V <sub>out_diff</sub> | Differential voltage between V <sub>SA</sub> , OUT1 <sub>A</sub> , OUT2 <sub>A</sub> , PGND and V <sub>SB</sub> , OUT1 <sub>B</sub> , OUT2 <sub>B</sub> , PGND pins | V <sub>SA</sub> = V <sub>SB</sub> = V <sub>S</sub>  |       |     | 45               | V    |
| V <sub>REG,in</sub>   | Logic supply voltage                                                                                                                                                | V <sub>REG</sub> voltage imposed by external source | 3.2   | 3.3 |                  | V    |
| V <sub>ADC</sub>      | Integrated ADC input voltage (ADCIN pin)                                                                                                                            |                                                     | 0     |     | V <sub>REG</sub> | V    |

## 2.3 Thermal data

Table 4. Thermal data

| Symbol            | Parameter                           | Package                  | Typ. | Unit |
|-------------------|-------------------------------------|--------------------------|------|------|
| R <sub>thJA</sub> | Thermal resistance junction-ambient | HTSSOP28 <sup>(1)</sup>  | 22   | °C/W |
|                   |                                     | POWERSO36 <sup>(2)</sup> | 12   |      |

1. HTSSOP28 mounted on EVAL6474H Rev 1.0 board: four-layer FR4 PCB with a dissipating copper surface of about 40 cm<sup>2</sup> on each layer and 15 via holes below the IC.
2. POWERSO36 mounted on EVAL6474PD Rev 1.0 board: four-layer FR4 PCB with a dissipating copper surface of about 40 cm<sup>2</sup> on each layer and 22 via holes below the IC.

### 3 Electrical characteristics

$V_{SA} = V_{SB} = 36\text{ V}$ ;  $V_{DD} = 3.3\text{ V}$ ; internal 3 V regulator;  $T_J = 25\text{ °C}$ , unless otherwise specified.

**Table 5. Electrical characteristics**

| Symbol                        | Parameter                                               | Test condition                                                             | Min. | Typ. | Max. | Unit     |
|-------------------------------|---------------------------------------------------------|----------------------------------------------------------------------------|------|------|------|----------|
| <b>General</b>                |                                                         |                                                                            |      |      |      |          |
| $V_{SthOn}$                   | $V_S$ UVLO turn-on threshold                            |                                                                            | 7.5  | 8.2  | 8.9  | V        |
| $V_{SthOff}$                  | $V_S$ UVLO turn-off threshold                           |                                                                            | 6.6  | 7.2  | 7.8  | V        |
| $V_{SthHyst}$                 | $V_S$ UVLO threshold hysteresis                         |                                                                            | 0.7  | 1    | 1.3  | V        |
| $I_q$                         | Quiescent motor supply current                          | Internal oscillator selected;<br>$V_{REG} = 3.3\text{ V}$ ext; CP floating |      | 0.5  | 0.65 | mA       |
| $T_{j(WRN)}$                  | Thermal warning temperature                             |                                                                            |      | 130  |      | °C       |
| $T_{j(SD)}$                   | Thermal shutdown temperature                            |                                                                            |      | 160  |      | °C       |
| <b>Charge pump</b>            |                                                         |                                                                            |      |      |      |          |
| $V_{pump}$                    | Voltage swing for charge pump oscillator                |                                                                            |      | 10   |      | V        |
| $f_{pump,min}$                | Minimum charge pump oscillator frequency <sup>(1)</sup> |                                                                            |      | 660  |      | kHz      |
| $f_{pump,max}$                | Maximum charge pump oscillator frequency <sup>(1)</sup> |                                                                            |      | 800  |      | kHz      |
| $I_{boot}$                    | Average boot current                                    | $f_{sw,A} = f_{sw,B} = 15.6\text{ kHz}$<br>POW_SR = '10'                   |      | 1.1  | 1.4  | mA       |
| <b>Output DMOS transistor</b> |                                                         |                                                                            |      |      |      |          |
| $R_{DS(on)}$                  | High-side switch ON resistance                          | $T_J = 25\text{ °C}$ , $I_{out} = 3\text{ A}$                              |      | 0.37 |      | $\Omega$ |
|                               |                                                         | $T_J = 125\text{ °C}$ , <sup>(2)</sup> $I_{out} = 3\text{ A}$              |      | 0.51 |      |          |
|                               | Low-side switch ON resistance                           | $T_J = 25\text{ °C}$ , $I_{out} = 3\text{ A}$                              |      | 0.18 |      |          |
|                               |                                                         | $T_J = 125\text{ °C}$ , <sup>(2)</sup> $I_{out} = 3\text{ A}$              |      | 0.23 |      |          |
| $I_{DSS}$                     | Leakage current                                         | OUT = $V_S$                                                                |      |      | 3.1  | mA       |
|                               |                                                         | OUT = GND                                                                  | -0.3 |      |      |          |
| $t_r$                         | Rise time <sup>(3)</sup>                                | POW_SR = '00', $I_{out} = +1\text{ A}$                                     |      | 100  |      | ns       |
|                               |                                                         | POW_SR = '00', $I_{out} = -1\text{ A}$                                     |      | 80   |      |          |
|                               |                                                         | POW_SR = '11', $I_{out} = \pm 1\text{ A}$                                  |      | 100  |      |          |
|                               |                                                         | POW_SR = '10', $I_{out} = \pm 1\text{ A}$                                  |      | 200  |      |          |
|                               |                                                         | POW_SR = '01', $I_{out} = \pm 1\text{ A}$                                  |      | 300  |      |          |

Table 5. Electrical characteristics (continued)

| Symbol                | Parameter                             | Test condition                              | Min. | Typ. | Max. | Unit |
|-----------------------|---------------------------------------|---------------------------------------------|------|------|------|------|
| $t_f$                 | Fall time <sup>(3)</sup>              | POW_SR = '00'; I <sub>out</sub> = +1 A      |      | 90   |      | ns   |
|                       |                                       | POW_SR = '00'; I <sub>out</sub> = -1 A      |      | 110  |      |      |
|                       |                                       | POW_SR = '11', I <sub>out</sub> = ±1 A      |      | 110  |      |      |
|                       |                                       | POW_SR = '10', I <sub>out</sub> = ±1 A      |      | 260  |      |      |
|                       |                                       | POW_SR = '01', I <sub>load</sub> = ±1 A     |      | 375  |      |      |
| SR <sub>out_r</sub>   | Output rising slew rate               | POW_SR = '00', I <sub>out</sub> = +1 A      |      | 285  |      | V/μs |
|                       |                                       | POW_SR = '00', I <sub>out</sub> = -1 A      |      | 360  |      |      |
|                       |                                       | POW_SR = '11', I <sub>out</sub> = ±1 A      |      | 285  |      |      |
|                       |                                       | POW_SR = '10', I <sub>out</sub> = ±1 A      |      | 150  |      |      |
|                       |                                       | POW_SR = '01', I <sub>out</sub> = ±1 A      |      | 95   |      |      |
| SR <sub>out_f</sub>   | Output falling slew rate              | POW_SR = '00', I <sub>out</sub> = +1 A      |      | 320  |      | V/μs |
|                       |                                       | POW_SR = '00', I <sub>out</sub> = -1 A      |      | 260  |      |      |
|                       |                                       | POW_SR = '11', I <sub>out</sub> = ±1 A      |      | 260  |      |      |
|                       |                                       | POW_SR = '10', I <sub>out</sub> = ±1 A      |      | 110  |      |      |
|                       |                                       | POW_SR = '01', I <sub>out</sub> = ±1 A      |      | 75   |      |      |
| Deadtime and blanking |                                       |                                             |      |      |      |      |
| $t_{DT}$              | Deadtime <sup>(1)</sup>               | POW_SR = '00'                               |      | 250  |      | ns   |
|                       |                                       | POW_SR = '11',<br>f <sub>osc</sub> = 16 MHz |      | 375  |      |      |
|                       |                                       | POW_SR = '10',<br>f <sub>osc</sub> = 16 MHz |      | 625  |      |      |
|                       |                                       | POW_SR = '01',<br>f <sub>osc</sub> = 16 MHz |      | 875  |      |      |
| t <sub>blank</sub>    | Blanking time <sup>(1)</sup>          | POW_SR = '00'                               |      | 250  |      | ns   |
|                       |                                       | POW_SR = '11',<br>f <sub>osc</sub> = 16 MHz |      | 375  |      |      |
|                       |                                       | POW_SR = '10',<br>f <sub>osc</sub> = 16 MHz |      | 625  |      |      |
|                       |                                       | POW_SR = '01',<br>f <sub>osc</sub> = 16 MHz |      | 875  |      |      |
| Source-drain diodes   |                                       |                                             |      |      |      |      |
| V <sub>SD,HS</sub>    | High-side diode forward ON voltage    | I <sub>out</sub> = 1 A                      |      | 1    | 1.1  | V    |
| V <sub>SD,LS</sub>    | Low-side diode forward ON voltage     | I <sub>out</sub> = 1 A                      |      | 1    | 1.1  | V    |
| t <sub>rrHS</sub>     | High-side diode reverse recovery time | I <sub>out</sub> = 1 A                      |      | 30   |      | ns   |
| t <sub>rrLS</sub>     | Low-side diode reverse recovery time  | I <sub>out</sub> = 1 A                      |      | 100  |      | ns   |

Table 5. Electrical characteristics (continued)

| Symbol                                                    | Parameter                                       | Test condition                                                                            | Min. | Typ. | Max. | Unit             |
|-----------------------------------------------------------|-------------------------------------------------|-------------------------------------------------------------------------------------------|------|------|------|------------------|
| <b>Logic inputs and outputs</b>                           |                                                 |                                                                                           |      |      |      |                  |
| $V_{IL}$                                                  | Low logic level input voltage                   |                                                                                           |      |      | 0.8  | V                |
| $V_{IH}$                                                  | High logic level input voltage                  |                                                                                           | 2    |      |      | V                |
| $I_{IH}$                                                  | High logic level input current <sup>(4)</sup>   | $V_{IN} = 5\text{ V}$                                                                     |      |      | 1    | $\mu\text{A}$    |
| $I_{IL}$                                                  | Low logic level input current <sup>(5)</sup>    | $V_{IN} = 0\text{ V}$                                                                     | -1   |      |      | $\mu\text{A}$    |
| $V_{OL}$                                                  | Low logic level output voltage <sup>(6)</sup>   | $V_{DD} = 3.3\text{ V}, I_{OL} = 4\text{ mA}$                                             |      |      | 0.3  | V                |
|                                                           |                                                 | $V_{DD} = 5\text{ V}, I_{OL} = 4\text{ mA}$                                               |      |      | 0.3  |                  |
| $V_{OH}$                                                  | High logic level output voltage                 | $V_{DD} = 3.3\text{ V}, I_{OH} = 4\text{ mA}$                                             | 2.4  |      |      | V                |
|                                                           |                                                 | $V_{DD} = 5\text{ V}, I_{OH} = 4\text{ mA}$                                               | 4.7  |      |      |                  |
| $R_{PU}$<br>$R_{PD}$                                      | CS pull-up and STBY pull-down resistors         | $\overline{CS} = \text{GND};$<br>$\text{STBY}/\text{RST} = 5\text{ V}$                    | 335  | 430  | 565  | $\text{k}\Omega$ |
| $R_{PUDIR}$                                               | DIR input pull-up resistance                    | $\text{DIR} = \text{GND}$                                                                 | 60   | 85   | 110  | $\text{k}\Omega$ |
| $I_{logic}$                                               | Internal logic supply current                   | 3.3 V $V_{REG}$ externally supplied, internal oscillator                                  |      | 3.7  | 4.3  | mA               |
| $I_{logic,STBY}$                                          | Standby mode internal logic supply current      | 3.3 V $V_{REG}$ externally supplied                                                       |      | 2    | 2.5  | $\mu\text{A}$    |
| $f_{STCK}$                                                | Step clock input frequency                      |                                                                                           |      |      | 2    | MHz              |
| <b>Internal oscillator and external oscillator driver</b> |                                                 |                                                                                           |      |      |      |                  |
| $f_{osc,i}$                                               | Internal oscillator frequency                   | $T_j = 25\text{ }^\circ\text{C}, V_{REG} = 3.3\text{ V}$                                  | -3%  | 16   | +3%  | MHz              |
| $f_{osc,e}$                                               | Programmable external oscillator frequency      |                                                                                           | 8    |      | 32   | MHz              |
| $V_{OSCOUTH}$                                             | OSCOUT clock source high level voltage          | Internal oscillator 3.3 V<br>$V_{REG}$ externally supplied;<br>$I_{OSCOUT} = 4\text{ mA}$ | 2.4  |      |      | V                |
| $V_{OSCOUTL}$                                             | OSCOUT clock source low level voltage           | Internal oscillator 3.3 V<br>$V_{REG}$ externally supplied;<br>$I_{OSCOUT} = 4\text{ mA}$ |      |      | 0.3  | V                |
| $t_{rOSCOUT}$<br>$t_{fOSCOUT}$                            | OSCOUT clock source rise and fall time          | Internal oscillator                                                                       |      |      | 20   | ns               |
| $t_{extosc}$                                              | Internal to external oscillator switching delay |                                                                                           |      | 3    |      | ms               |
| $t_{intosc}$                                              | External to internal oscillator switching delay |                                                                                           |      | 1.5  |      | $\mu\text{s}$    |
| <b>SPI</b>                                                |                                                 |                                                                                           |      |      |      |                  |
| $f_{CK,MAX}$                                              | Maximum SPI clock frequency <sup>(7)</sup>      |                                                                                           | 5    |      |      | MHz              |
| $t_{rCK}$<br>$t_{fCK}$                                    | SPI clock rise and fall time <sup>(7)</sup>     | $C_L = 30\text{ pF}$                                                                      |      |      | 25   | ns               |
| $t_{hCK}$<br>$t_{lCK}$                                    | SPI clock high and low time <sup>(7)</sup>      |                                                                                           | 75   |      |      | ns               |
| $t_{setCS}$                                               | Chip select setup time <sup>(7)</sup>           |                                                                                           | 350  |      |      | ns               |
| $t_{holCS}$                                               | Chip select hold time <sup>(7)</sup>            |                                                                                           | 10   |      |      | ns               |

Table 5. Electrical characteristics (continued)

| Symbol                                        | Parameter                                               | Test condition                                              | Min. | Typ.  | Max. | Unit    |
|-----------------------------------------------|---------------------------------------------------------|-------------------------------------------------------------|------|-------|------|---------|
| $t_{disCS}$                                   | Deselect time <sup>(7)</sup>                            |                                                             | 800  |       |      | ns      |
| $t_{setSDI}$                                  | Data input setup time <sup>(7)</sup>                    |                                                             | 25   |       |      | ns      |
| $t_{holSDI}$                                  | Data input hold time <sup>(7)</sup>                     |                                                             | 20   |       |      | ns      |
| $t_{enSDO}$                                   | Data output enable time <sup>(7)</sup>                  |                                                             |      |       | 38   | ns      |
| $t_{disSDO}$                                  | Data output disable time <sup>(7)</sup>                 |                                                             |      |       | 47   | ns      |
| $t_{vSDO}$                                    | Data output valid time <sup>(7)</sup>                   |                                                             |      |       | 57   | ns      |
| $t_{holSDO}$                                  | Data output hold time <sup>(7)</sup>                    |                                                             | 37   |       |      | ns      |
| <b>Current control</b>                        |                                                         |                                                             |      |       |      |         |
| $I_{STEP,max}$                                | Max. programmable reference current                     |                                                             |      | 4     |      | A       |
| $I_{STEP,min}$                                | Min. programmable reference current                     |                                                             |      | 31    |      | mA      |
| <b>Overcurrent protection</b>                 |                                                         |                                                             |      |       |      |         |
| $I_{OCD,MAX}$                                 | Maximum programmable overcurrent detection threshold    | OCD_TH = '1111'                                             |      | 6     |      | A       |
| $I_{OCD,MIN}$                                 | Minimum programmable overcurrent detection threshold    | OCD_TH = '0000'                                             |      | 0.375 |      | A       |
| $I_{OCD,RES}$                                 | Programmable overcurrent detection threshold resolution |                                                             |      | 0.375 |      | A       |
| $t_{OCD,Flag}$                                | OCD to flag signal delay time                           | $dI_{out}/d_t = 350A/\mu s$                                 |      | 650   | 1000 | ns      |
| $t_{OCD,SD}$                                  | OCD to shut down delay time                             | $dI_{out}/d_t = 350A/\mu s$ POW_SR = '10'                   |      | 600   |      | $\mu s$ |
| <b>Standby</b>                                |                                                         |                                                             |      |       |      |         |
| $I_{qSTBY}$                                   | Quiescent motor supply current in standby conditions    | $V_S = 8 V$                                                 |      | 26    | 34   | $\mu A$ |
|                                               |                                                         | $V_S = 36 V$                                                |      | 30    | 36   |         |
| $t_{STBY,min}$                                | Minimum standby time                                    |                                                             |      | 10    |      | $\mu s$ |
| $t_{logicwu}$                                 | Logic power-on and wake-up time                         |                                                             |      | 38    | 45   | $\mu s$ |
| $t_{cpwu}$                                    | Charge pump power-on and wake-up time                   | Power bridges disabled, $C_p = 10 nF$ , $C_{boot} = 220 nF$ |      | 650   |      | $\mu s$ |
| <b>Internal voltage regulator</b>             |                                                         |                                                             |      |       |      |         |
| $V_{REG}$                                     | Voltage regulator output voltage                        |                                                             | 2.9  | 3     | 3.2  | V       |
| $I_{REG}$                                     | Voltage regulator output current                        |                                                             |      |       | 40   | mA      |
| $V_{REG,drop}$                                | Voltage regulator output voltage drop                   | $I_{REG} = 40 mA$                                           |      | 50    |      | mV      |
| $I_{REG,STBY}$                                | Voltage regulator standby output current                |                                                             |      |       | 10   | mA      |
| <b>Integrated analog to digital converter</b> |                                                         |                                                             |      |       |      |         |
| $N_{ADC}$                                     | Analog to digital converter resolution                  |                                                             |      | 5     |      | bit     |

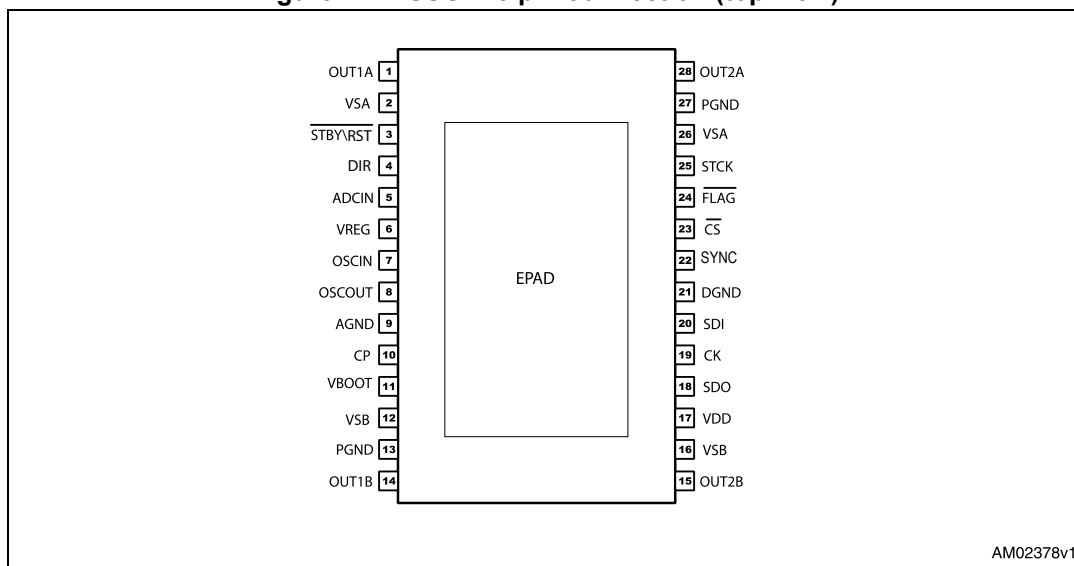
Table 5. Electrical characteristics (continued)

| Symbol               | Parameter                                      | Test condition | Min. | Typ.                 | Max. | Unit |
|----------------------|------------------------------------------------|----------------|------|----------------------|------|------|
| $V_{\text{ADC,ref}}$ | Analog to digital converter reference voltage  |                |      | $V_{\text{REG}}$     |      | V    |
| $f_{\text{S}}$       | Analog to digital converter sampling frequency |                |      | $f_{\text{OSC}}/512$ |      | kHz  |

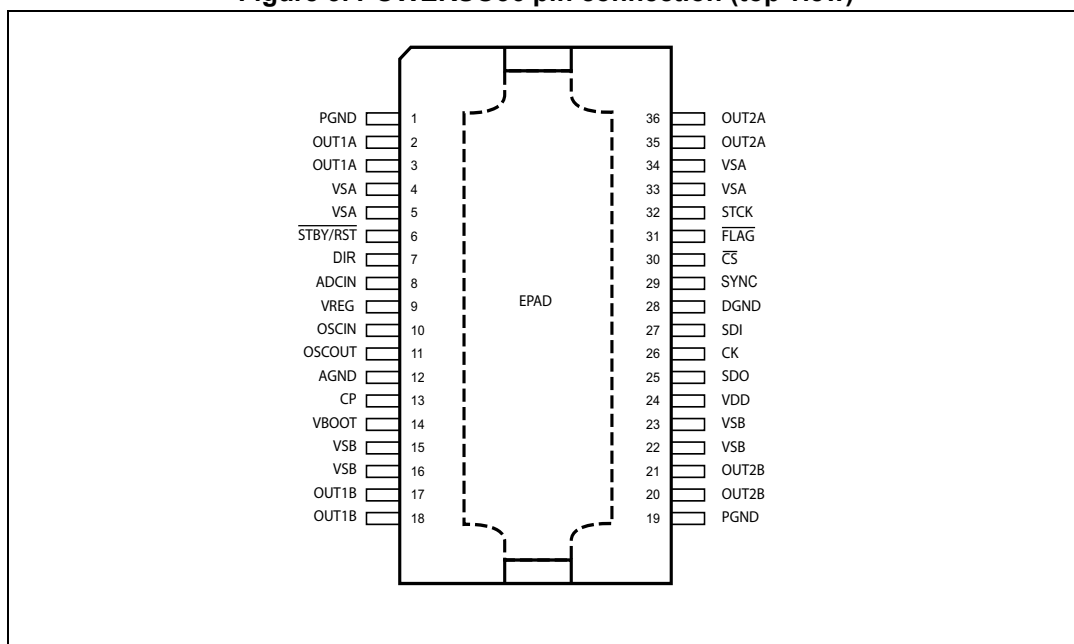
1. Accuracy depends on oscillator frequency accuracy.
2. Tested at 25 °C in a restricted range and guaranteed by characterization.
3. Rise and fall time depends on motor supply voltage value. Refer to  $\text{SR}_{\text{out}}$  values ([Table 5](#)) in order to evaluate the actual rise and fall time.
4. Not valid for  $\overline{\text{STBY/RST}}$  pins which have internal pull-down resistor.
5. Not valid for SW and CS pins which have internal pull-up resistor.
6.  $\overline{\text{FLAG}}$  and SYNC open drain outputs included.
7. See [Figure 13: SPI timings diagram](#) for details.

## 4 Pin connection

**Figure 2. HTSSOP28 pin connection (top view)**



**Figure 3. POWERSO36 pin connection (top view)**



## Pin list

Table 6. Pin description

| Number  |        | Name                   | Type              | Function                                                                                                                                                                       |
|---------|--------|------------------------|-------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| POWERSO | HTSSOP |                        |                   |                                                                                                                                                                                |
| 24      | 17     | VDD                    | Power             | Logic outputs supply voltage (pull-up reference)                                                                                                                               |
| 9       | 6      | VREG                   | Power             | Internal 3 V voltage regulator output and 3.3 V external logic supply                                                                                                          |
| 10      | 7      | OSCIN                  | Analog input      | Oscillator pin 1. To connect an external oscillator or clock source. If this pin is unused, it should be left floating.                                                        |
| 11      | 8      | OSCOU                  | Analog output     | Oscillator pin 2. To connect an external oscillator. When the internal oscillator is used this pin can supply 2/4/8/16 MHz. If this pin is unused, it should be left floating. |
| 13      | 10     | CP                     | Output            | Charge pump oscillator output                                                                                                                                                  |
| 14      | 11     | VBOOT                  | Supply voltage    | Bootstrap voltage needed for driving the high-side power DMOS of both bridges (A and B)                                                                                        |
| 8       | 5      | ADCIN                  | Analog input      | Internal analog to digital converter input                                                                                                                                     |
| 4, 5    | 2      | VSA                    | Power supply      | Full bridge A power supply pin. It must be connected to VSB                                                                                                                    |
| 33, 34  | 26     |                        |                   |                                                                                                                                                                                |
| 15, 16  | 12     | VSB                    | Power supply      | Full bridge B power supply pin. It must be connected to VSA                                                                                                                    |
| 22, 23  | 16     |                        |                   |                                                                                                                                                                                |
| 1       | 27     | PGND                   | Ground            | Power ground pin                                                                                                                                                               |
| 19      | 13     |                        |                   |                                                                                                                                                                                |
| 2, 3    | 1      | OUT1A                  | Power output      | Full bridge A output 1                                                                                                                                                         |
| 35, 36  | 28     | OUT2A                  | Power output      | Full bridge A output 2                                                                                                                                                         |
| 17, 18  | 14     | OUT1B                  | Power output      | Full bridge B output 1                                                                                                                                                         |
| 20, 21  | 15     | OUT2B                  | Power output      | Full bridge B output 2                                                                                                                                                         |
| 12      | 9      | AGND                   | Ground            | Analog ground                                                                                                                                                                  |
| 7       | 4      | DIR                    | Logical input     | Direction input                                                                                                                                                                |
| 28      | 21     | DGND                   | Ground            | Digital ground                                                                                                                                                                 |
| 29      | 22     | SYNC                   | Open drain output | Synchronization signal.                                                                                                                                                        |
| 25      | 18     | SDO                    | Logic output      | Data output pin for serial interface                                                                                                                                           |
| 27      | 20     | SDI                    | Logic input       | Data input pin for serial interface                                                                                                                                            |
| 26      | 19     | CK                     | Logic input       | Serial interface clock                                                                                                                                                         |
| 30      | 23     | $\overline{\text{CS}}$ | Logic input       | Chip select input pin for serial interface                                                                                                                                     |



Table 6. Pin description (continued)

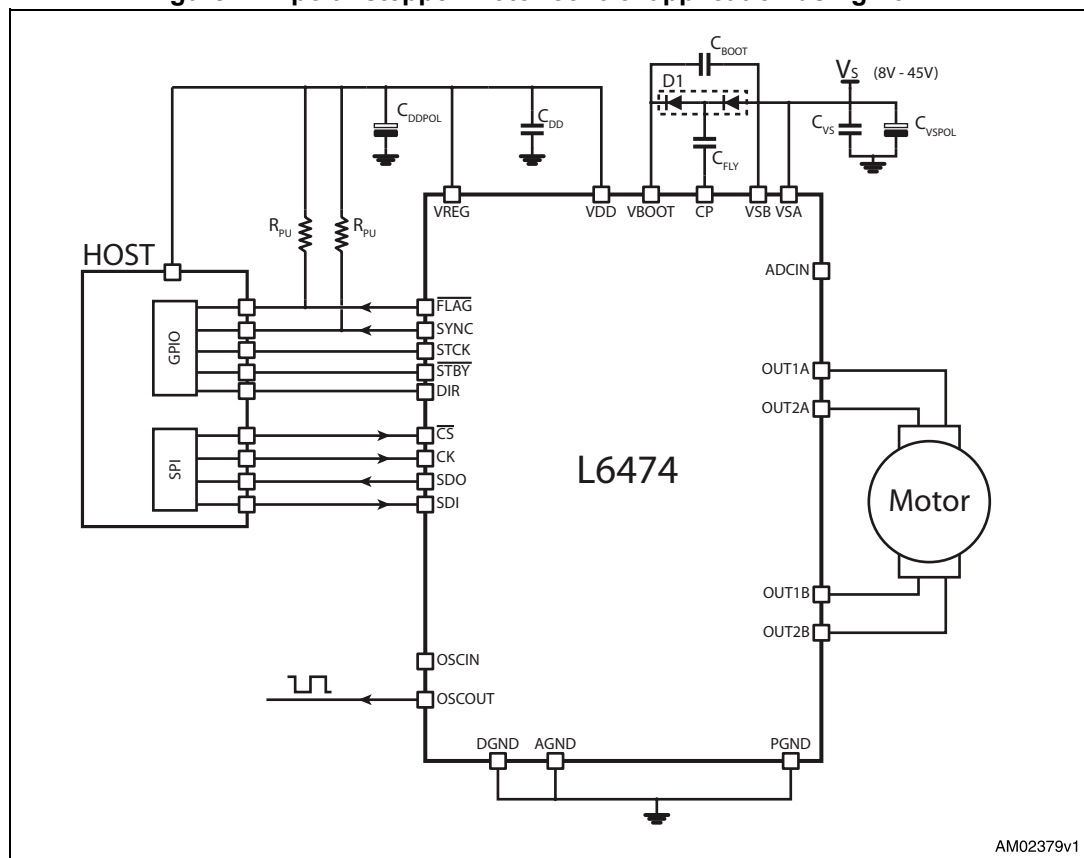
| Number  |        | Name                        | Type              | Function                                                                                                                                                                                                            |
|---------|--------|-----------------------------|-------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| POWERSO | HTSSOP |                             |                   |                                                                                                                                                                                                                     |
| 31      | 24     | $\overline{\text{FLAG}}$    | Open drain output | Status flag pin. An internal open drain transistor can pull the pin to GND when a programmed alarm condition occurs (step loss, OCD, thermal pre-warning or shutdown, UVLO, wrong command, non performable command) |
| 6       | 3      | $\overline{\text{STBYRST}}$ | Logic input       | Standby and reset pin. LOW logic level resets the logic and puts the device into standby mode. If not used, should be connected to VDD                                                                              |
| 32      | 25     | STCK                        | Logic input       | Step clock input                                                                                                                                                                                                    |
|         | EPAD   | Exposed pad                 | Ground            | Internally connected to PGND, AGND and DGND pins                                                                                                                                                                    |

## 5 Typical applications

Table 7. Typical application values

| Name         | Value              |
|--------------|--------------------|
| $C_{VS}$     | 220 nF             |
| $C_{VSPOL}$  | 100 $\mu$ F        |
| $C_{REG}$    | 100 nF             |
| $C_{REGPOL}$ | 47 $\mu$ F         |
| $C_{DD}$     | 100 nF             |
| $C_{DDPOL}$  | 10 $\mu$ F         |
| D1           | Charge pump diodes |
| $C_{BOOT}$   | 220 nF             |
| $C_{FLY}$    | 10 nF              |
| $R_{PU}$     | 39 k $\Omega$      |
| $R_{SW}$     | 100 $\Omega$       |
| $C_{SW}$     | 10 nF              |

Figure 4. Bipolar stepper motor control application using L6474



AM02379v1

## 6 Functional description

### 6.1 Device power-up

At power-up end, the device state is the following:

- Registers are set to default
- Internal logic is driven by internal oscillator and a 2 MHz clock is provided by the OSCOUT pin
- Bridges are disabled (High Z)
- UVLO bit in STATUS register is forced low (fail condition)
- FLAG output is forced low.

During power-up the device is under reset (all logic IO disabled and power bridges in high impedance state) until the following conditions are satisfied:

- $V_S$  is greater than  $V_{SthOn}$
- $V_{REG}$  is greater than  $V_{REGth} = 2.8\text{ V}$  typical
- Internal oscillator is operative.

### 6.2 Logic I/O

Pins  $\overline{CS}$ , CK, SDI, STCK, DIR and  $\overline{STBY/RST}$  are TTL/CMOS 3.3 V - 5 V compatible logic inputs.

Pin SDO is a TTL/CMOS compatible logic output. VDD pin voltage sets the logic output pin voltage range; when it is connected to VREG or 3.3 V external supply voltage, the output is 3.3 V compatible. When VDD is connected to a 5 V supply voltage, SDO is 5 V compatible.

VDD is not internally connected to  $V_{REG}$ , an external connection is always needed.

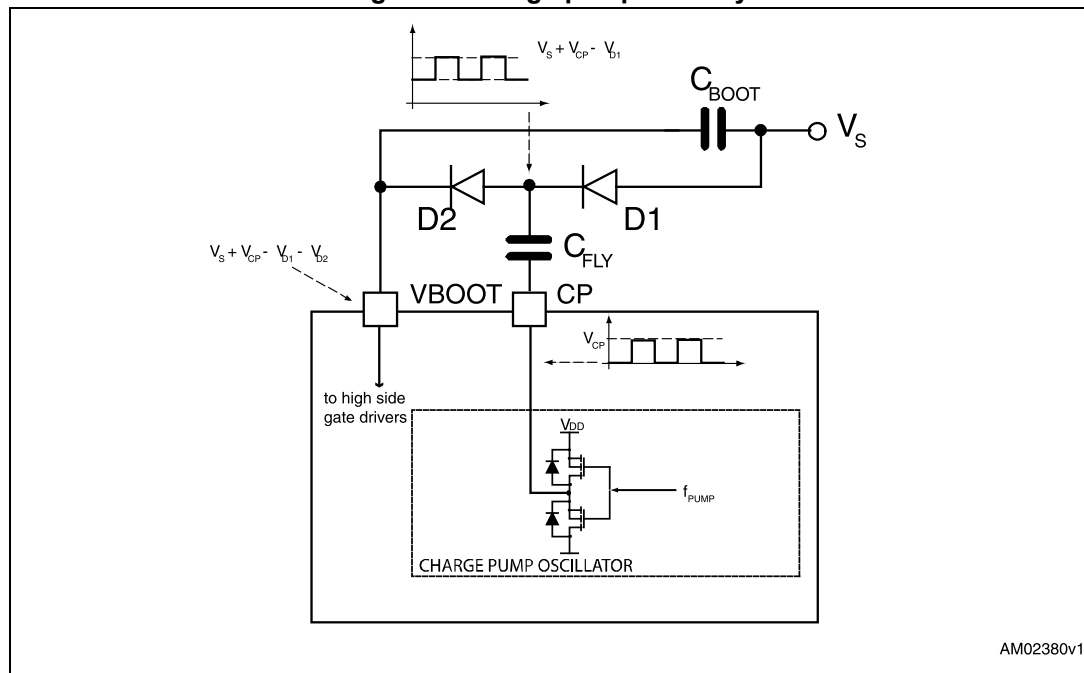
A 10  $\mu\text{F}$  capacitor should be connected to the VDD pin in order to obtain a proper operation.

Pins  $\overline{FLAG}$  and SYNC are open drain outputs.

### 6.3 Charge pump

To ensure the correct driving of the high-side integrated MOSFETs, a voltage higher than the motor power supply voltage needs to be applied to the VBOOT pin. The high-side gate driver supply voltage VBOOT is obtained through an oscillator and a few external components realizing a charge pump (see [Figure 5](#)).

Figure 5. Charge pump circuitry

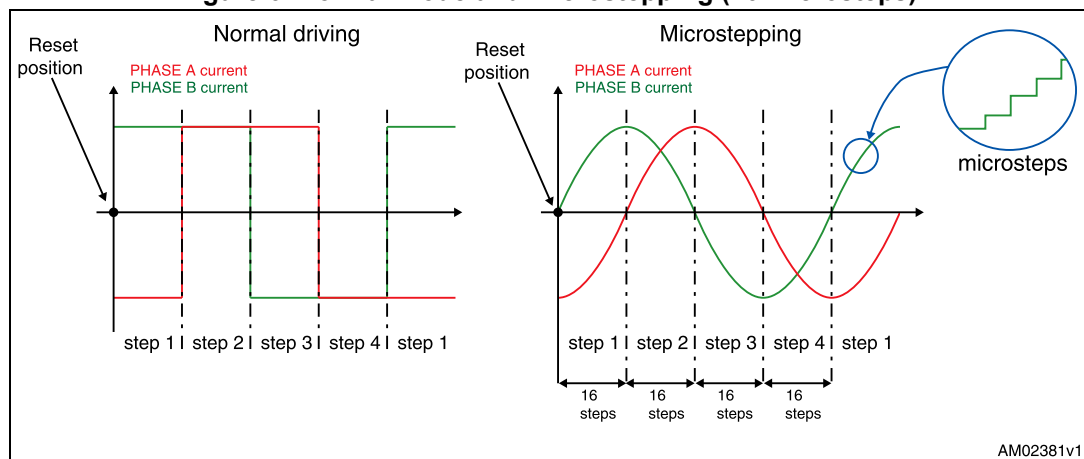


## 6.4 Microstepping

The driver is able to divide the single step into up to 16 microsteps. Stepping mode can be programmed by STEP\_SEL parameter in STEP\_MODE register (see [Table 19 on page 38](#)).

Step mode can only be changed when bridges are disabled. Every time the step mode is changed, the electrical position (i.e. the point of microstepping sinewave that is generated) is reset to the first microstep and the absolute position counter value (see [Section 6.5](#)) becomes meaningless.

Figure 6. Normal mode and microstepping (16 microsteps)



## 6.5 Absolute position counter

An internal 22 bit register (ABS\_POS) takes memory of motor motion according to the selected step mode; the stored value unit is equal to the selected step mode (full, half, quarter, etc.). The position range is from  $-2^{21}$  to  $+2^{21}-1$  ( $\mu$ ) steps (see [Section 9.1.1 on page 34](#)).

## 6.6 Step sequence control

The motor movement is defined by the step clock signal applied to the STCK pin. At each step clock rising edge, the motor is moved by one microstep in the direction selected by DIR input (high for forward direction and low for reverse direction) and absolute position is consequently updated.

## 6.7 Enable and disable commands

The power stage of the device can be enabled and disabled through the respective SPI commands.

The enable command turns on the power outputs and starts the current control algorithm. The phase currents are controlled according to present EL\_POS value. If a fault condition requires the power stage to be disabled, the command is ignored.

The disable command immediately forces the power outputs in a high impedance condition.

## 6.8 Internal oscillator and oscillator driver

The control logic clock can be supplied by the internal 16 MHz oscillator, an external oscillator (crystal or ceramic resonator) or a direct clock signal.

These working modes can be selected by EXT\_CLK and OSC\_SEL parameters in the CONFIG register (see [Table 23 on page 40](#)).

At power-up the device starts using the internal oscillator and provides a 2 MHz clock signal on the OSCOUT pin.

---

**Attention:** In any case, before changing clock source configuration, a hardware reset is mandatory. Switching to different clock configurations during operation could cause unexpected behavior.

---

### 6.8.1 Internal oscillator

In this mode the internal oscillator is activated and OSCIN is unused. If OSCOUT clock source is enabled, the OSCOUT pin provides a 2, 4, 8 or 16 MHz clock signal (according to OSC\_SEL value); otherwise it is unused (see [Figure 7](#)).

### 6.8.2 External clock source

Two types of external clock source can be selected: crystal/ceramic resonator or direct clock source. Four programmable clock frequencies are available for each external clock source: 8, 16, 24 and 32 MHz.

When an external crystal/resonator is selected, the OSCIN and OSCOUT pins are used to drive the crystal/resonator (see [Figure 7](#)). The crystal/resonator and load capacitors (CL) must be placed as close as possible to the pins. Refer to [Table 8](#) for the choice of the load capacitor value according to the external oscillator frequency.

**Table 8. CL values according to external oscillator frequency**

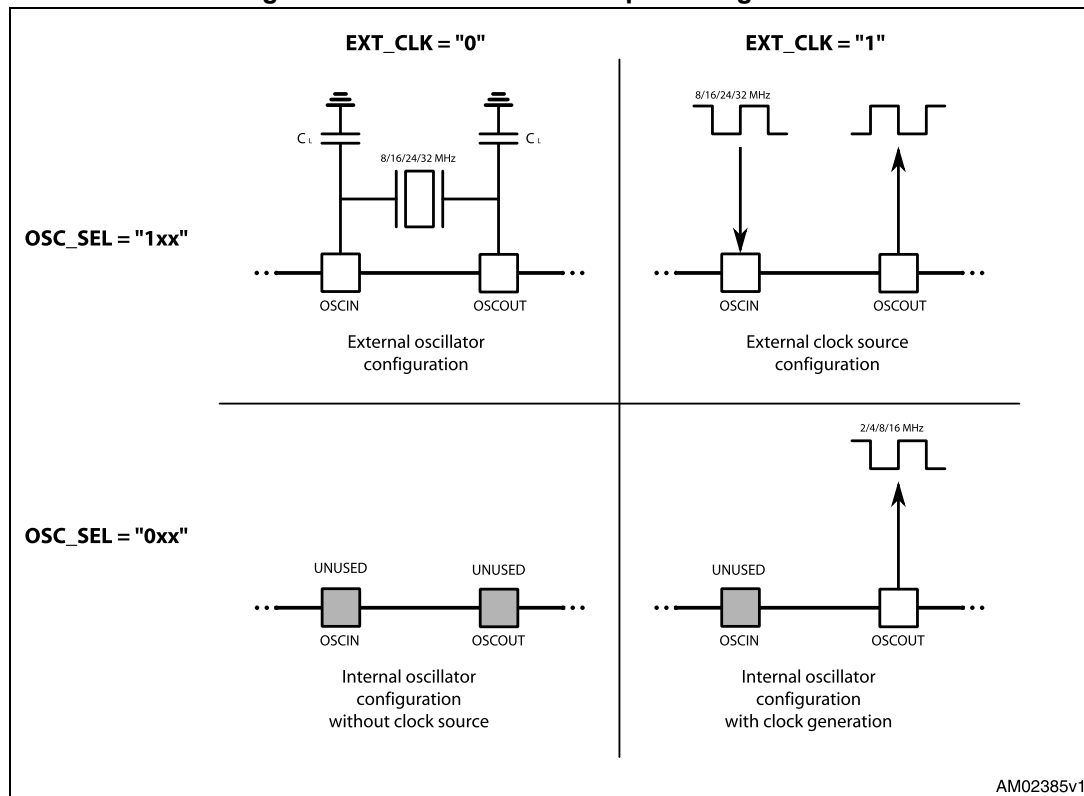
| Crystal/resonator freq. <sup>(1)</sup> | CL <sup>(2)</sup>                 |
|----------------------------------------|-----------------------------------|
| 8 MHz                                  | 25 pF (ESR <sub>max</sub> = 80 Ω) |
| 16 MHz                                 | 18 pF (ESR <sub>max</sub> = 50 Ω) |
| 24 MHz                                 | 15 pF (ESR <sub>max</sub> = 40 Ω) |
| 32 MHz                                 | 10 pF (ESR <sub>max</sub> = 40 Ω) |

1. First harmonic resonance frequency.

2. Lower ESR value allows driving greater load capacitors.

If a direct clock source is used, it must be connected to the OSCIN pin and the OSCOUT pin supplies the inverted OSCIN signal (see [Figure 7](#)).

Figure 7. OSCIN and OSCOUT pin configurations



**Note:** When OSCIN is UNUSED, it should be left floating.  
When OSCOUT is UNUSED it should be left floating.

## 6.9 Overcurrent detection

When the current in any of the power MOSFETs exceeds a programmed overcurrent threshold, the STATUS register OCD flag is forced low until the overcurrent event has expired and a GetStatus command is sent to the IC (see [Section 9.1.13 on page 41](#) and [Section 9.1.9 on page 37](#)). Overcurrent event expires when all the power MOSFET currents fall below the programmed overcurrent threshold.

The overcurrent threshold can be programmed through the OCD\_TH register in one of 16 available values ranging from 375 mA to 6 A with steps of 375 mA (see [Section 9.1.9 on page 37](#)).

It is possible to set whether or not an overcurrent event causes the MOSFET turn-off (bridges in high impedance status) acting on the OC\_SD bit in the CONFIG register (see [Section 9.1.12 on page 39](#)). The OCD flag in the STATUS register is raised anyway (see [Table 28 on page 41](#), [Section 9.1.13](#)).

When the IC outputs are turned off by an OCD event, they cannot be turned on until the OCD flag is released by a GetStatus command.

---

**Attention:** The overcurrent shutdown is a critical protection feature. It is not recommended to disable it.

---

## 6.10 Undervoltage lockout (UVLO)

The L6474 provides a motor supply UVLO protection. When the motor supply voltage falls below the VSthOff threshold voltage, the STATUS register UVLO flag is forced low. When a GetStatus command is sent to the IC, and the undervoltage condition has expired, the UVLO flag is released (see [Section 9.1.13 on page 41](#) and [Section 9.2.7 on page 46](#)). Undervoltage condition expires when the motor supply voltage goes over the VSthOn threshold voltage. When the device is in undervoltage condition no motion can be performed. The UVLO flag is forced low by logic reset (power-up included) even if no UVLO condition is present.

## 6.11 Thermal warning and thermal shutdown

An internal sensor allows the L6474 to detect when the device internal temperature exceeds a thermal warning or an overtemperature threshold.

When the thermal warning threshold ( $T_{j(WRN)}$ ) is reached, the TH\_WRN bit in the STATUS register is forced low (see [Section 9.1.13](#)) until the temperature decreases below  $T_{j(WRN)}$  and a GetStatus command is sent to the IC (see [Section 9.1.13](#) and [Section 9.2.7](#)).

When the thermal shutdown threshold ( $T_{j(OFF)}$ ) is reached, the device goes into thermal shutdown condition: the TH\_SD bit in the STATUS register is forced low, the power bridges are disabled, bridges in high impedance state and the HiZ bit in the STATUS register are raised (see [Section 9.1.13](#)).

Thermal shutdown condition only expires when the temperature goes below the thermal warning threshold ( $T_{j(WRN)}$ ).

On exiting thermal shutdown condition, the bridges are still disabled (HiZ flag high).

## 6.12 Reset and standby

The device can be reset and put into standby mode through a dedicated pin. When the STBY\RST pin is driven low, the bridges are left open (High Z state), the internal charge pump is stopped, the SPI interface and control logic are disabled, and the internal 3 V voltage regulator maximum output current is reduced to  $I_{REG,STBY}$ ; as a result the L6474 heavily reduces the power consumption. At the same time the register values are reset to default and all protection functions are disabled. STBY\RST input must be forced low at least for  $t_{STBY, min.}$  in order to ensure the complete switch to standby mode.

On exiting standby mode, as well as for IC power-up, a delay of up to  $t_{logicwu}$  must be given before applying a new command to allow proper oscillator and logic startup and a delay of up to  $t_{cpwu}$  must be given to allow the charge pump startup.

On exiting standby mode the bridges are disabled (HiZ flag high).



---

**Attention:** It is not recommended to reset the device when outputs are active. The device should be switched to high impedance state before being reset.

---

## 6.13 Programmable DMOS slew rate, deadtime and blanking-time

Using the POW\_SR parameter in the CONFIG register, it is possible to set the commutation speed of the power bridges output (see [Table 25 on page 41](#)).

## 6.14 Integrated analog to digital converter

The L6474 integrates a NADC bit ramp-compare analog to digital converter with a reference voltage equal to VREG. The analog to digital converter input is available through the ADCIN pin and the conversion result is available in the ADC\_OUT register (see [Section 9.1.13 on page 41](#)). Sampling frequency is equal to the clock frequency divided by 512.

The ADC\_OUT value can be used for the torque regulation or is at the user's disposal.

## 6.15 Internal voltage regulator

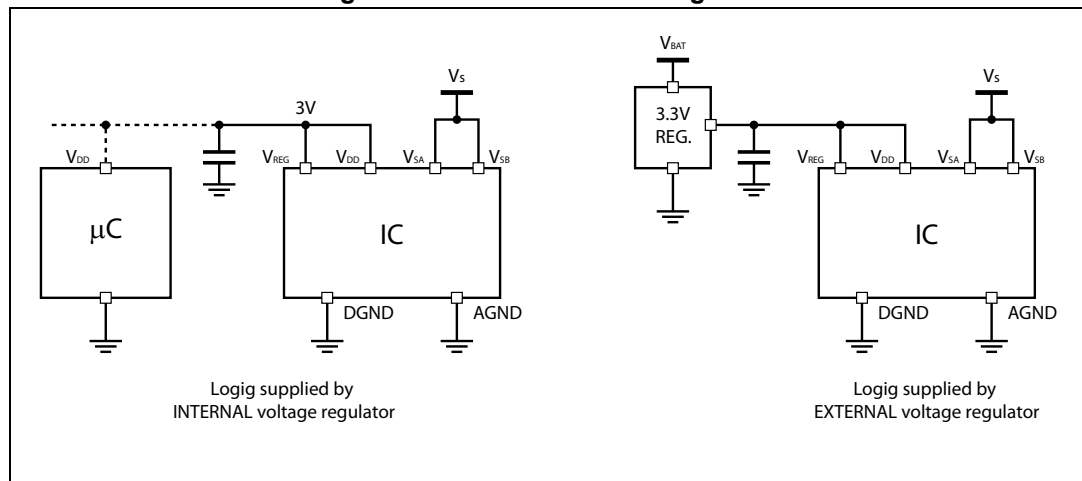
The L6474 integrates a voltage regulator which generates a 3 V voltage starting from the motor power supply (VSA and VSB). In order to make the voltage regulator stable, at least 22  $\mu\text{F}$  should be connected between the VREG pin and ground (suggested value is 47  $\mu\text{F}$ ).

The internal voltage regulator can be used to supply the VDD pin in order to make the device digital output range 3.3 V compatible ([Figure 8](#)). A digital output range 5 V compatible can be obtained connecting the VDD pin to an external 5 V voltage source. In both cases, a 10  $\mu\text{F}$  capacitance should be connected to the VDD pin in order to obtain a correct operation.

The internal voltage regulator is able to supply a current up to  $I_{\text{REG,MAX}}$ , internal logic consumption included ( $I_{\text{logic}}$ ). When the device is in standby mode the maximum current that can be supplied is  $I_{\text{REG, STBY}}$ , internal consumption included ( $I_{\text{logic, STBY}}$ ).

If an external 3.3 V regulated voltage is available, it can be applied to the VREG pin in order to supply all the internal logic and avoid power dissipation of the internal 3 V voltage regulator ([Figure 8](#)). The external voltage regulator should never sink current from the VREG pin.

Figure 8. Internal 3 V linear regulator



## 6.16 SYNC pin

This pin works as a synchronization signal: the output status is an echo of one of the bits of the EL\_POS register according to a SYNC\_SEL and STEP\_SEL parameter combination (see [Section 9.1.10 on page 38](#)).

## 6.17 FLAG pin

By default, an internal open drain transistor pulls the FLAG pin to ground when at least one of the following conditions occurs:

- Power-up or standby/reset exit
- Overcurrent detection
- Thermal warning
- Thermal shutdown
- UVLO
- Switch turn-on event
- Wrong command
- Non performable command.

It is possible to mask one or more alarm conditions by programming the ALARM\_EN register (see [Section 9.1.11 on page 39](#), [Table 21](#)). If the corresponding bit of the ALARM\_EN register is low, the alarm condition is masked and it does not cause a FLAG pin transition; all other actions imposed by alarm conditions are performed anyway. In case of daisy chain configuration, FLAG pins of different ICs can be or-wired to save host controller GPIOs.

## 7 Phase current control

The L6474 performs a peak current control technique described in detail in [Section 7.1](#). Furthermore, the L6474 automatically selects the best decay mode in order to follow the current profile.

Current control algorithm parameters can be programmed by T\_FAST, TON\_MIN, TOFF\_MIN and CONFIG registers (see [Section 9.1.5 on page 35](#), [Section 9.1.6 on page 35](#), [Section 9.1.7 on page 36](#) and [Section 9.1.12 on page 39](#) for details).

The current amplitude can be set through the TVAL register (see [Section 9.1.4 on page 34](#)). The output current amplitude can also be regulated by ADCIN voltage value (see [Section 6.14](#)).

Each bridge is driven by an independent control system that shares with the other bridge the control parameters only.

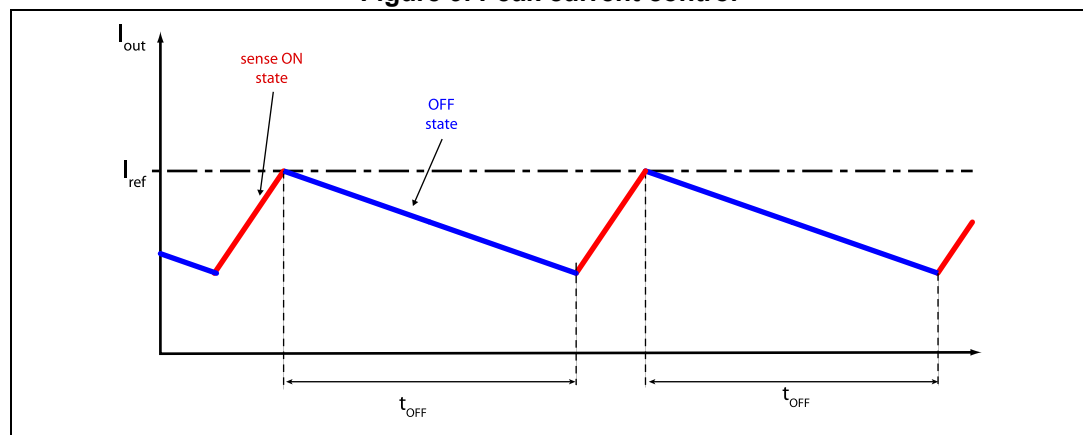
### 7.1 Peak current control

The L6474 implements a peak current control algorithm with fixed OFF time. The control cycle begins in the ON state: the opposite high-side DMOS low-side DMOS of the power bridges are turned on according to the required current direction. In this way, the phase current is increased according to the electrical model of the motor.

When the target current value is reached (this value is internally generated according to the present value of the EL\_POS register), the device switches to the OFF state in order to make the phase current decay. During the OFF state both slow and fast decay can be performed; the better decay combination is automatically selected by L6472 as described in [Section 7.2](#).

The  $t_{OFF}$  value sets through the TOFF parameter of the CONFIG register and the value of the TOFF\_MIN register. If TOFF is greater than TOFF\_MIN, it defines the OFF time of the system. Otherwise the TOFF\_MIN value is used.

Figure 9. Peak current control



## 7.2 Auto-adjusted decay mode

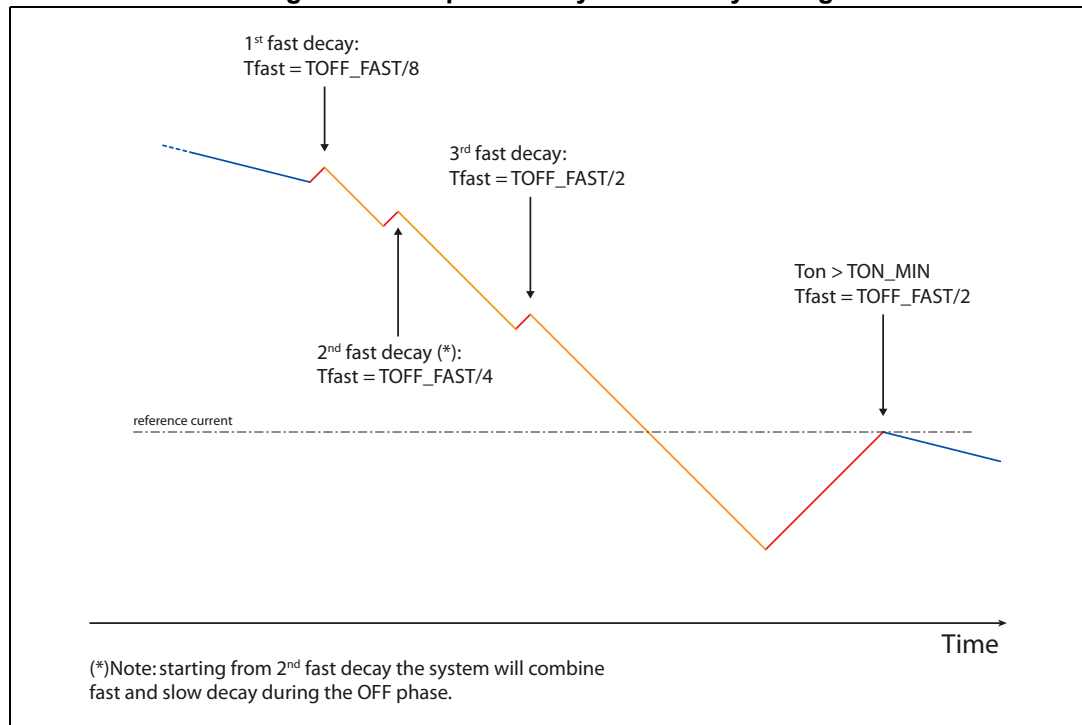
During the current control, the device automatically selects the best decay mode in order to follow the current profile reducing the current ripple.

At reset, the OFF time is performed by turning on both the low-side MOS of the power stage and the current recirculates in the lower half of the bridge (slow decay).

If, during a PWM cycle, the target current threshold is reached in a time shorter than the TON\_MIN value, a fast decay of TOFF\_FAST/8 (T\_FAST register) is immediately performed, turning on the opposite MOS of both half bridges and the current recirculates back to the supply bus.

After this time, the bridge returns to the ON state: if the time needed to reach the target current value is still less than TON\_MIN, a new fast decay is performed with a period twice the previous one. Otherwise, the normal control sequence is followed as described in [Section 7.1](#). The maximum fast decay duration is set by TOFF\_FAST value.

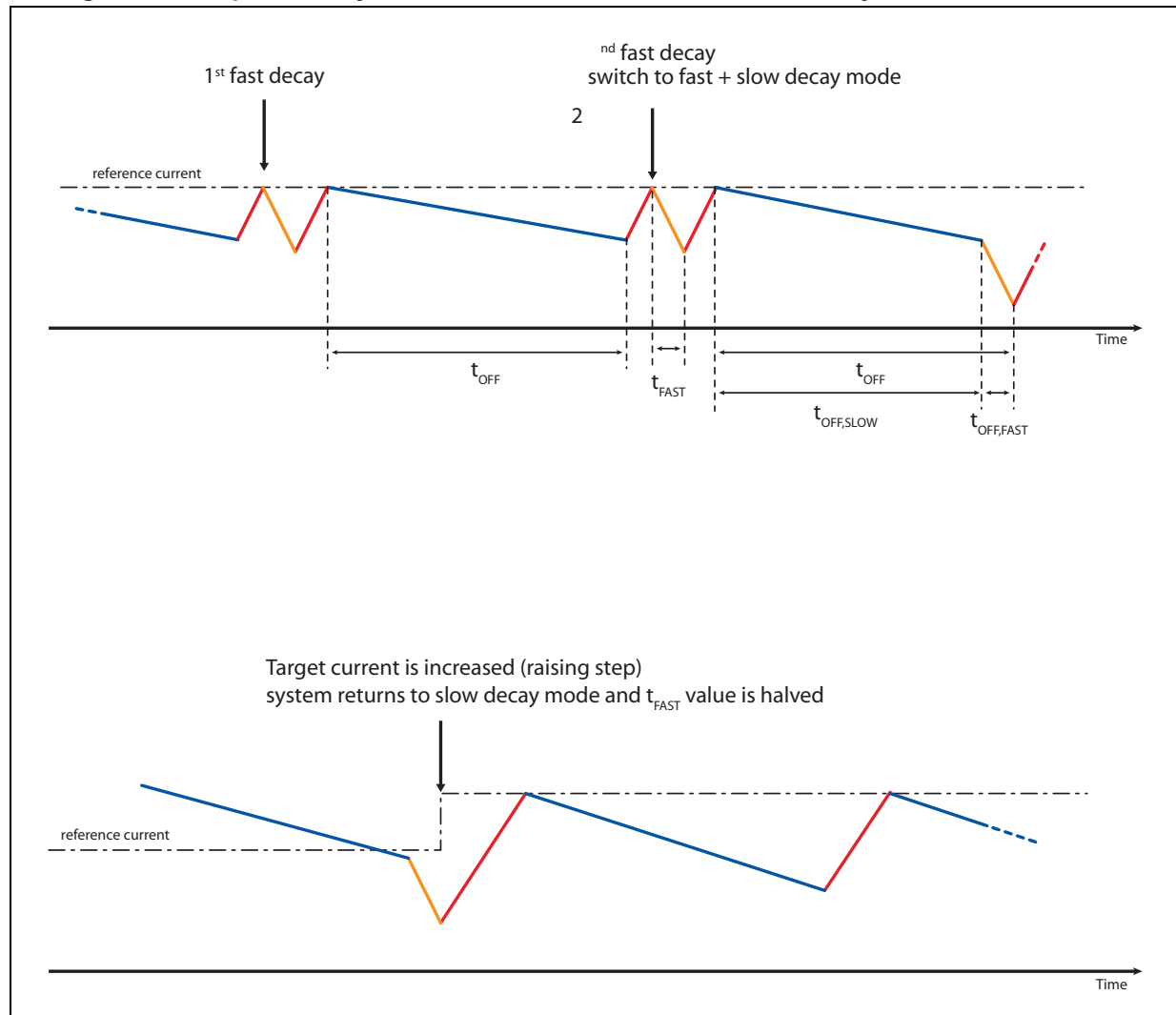
**Figure 10. Adaptive decay - fast decay tuning**



When two or more fast decays are performed with present target current, the control system adds a fast decay at the end of every OFF time, keeping the OFF state duration constant ( $t_{OFF}$  is split into  $t_{OFF,SLOW}$  and  $t_{OFF,FAST}$ ). When the current threshold is increased by a microstep change (rising step), the system returns to normal decay mode (slow decay only) and the  $t_{FAST}$  value is halved.

Reaching the current sinewave zero crossing causes the current control system to return to the reset state.

Figure 11. Adaptive decay - switch from normal to slow + fast decay mode and vice versa



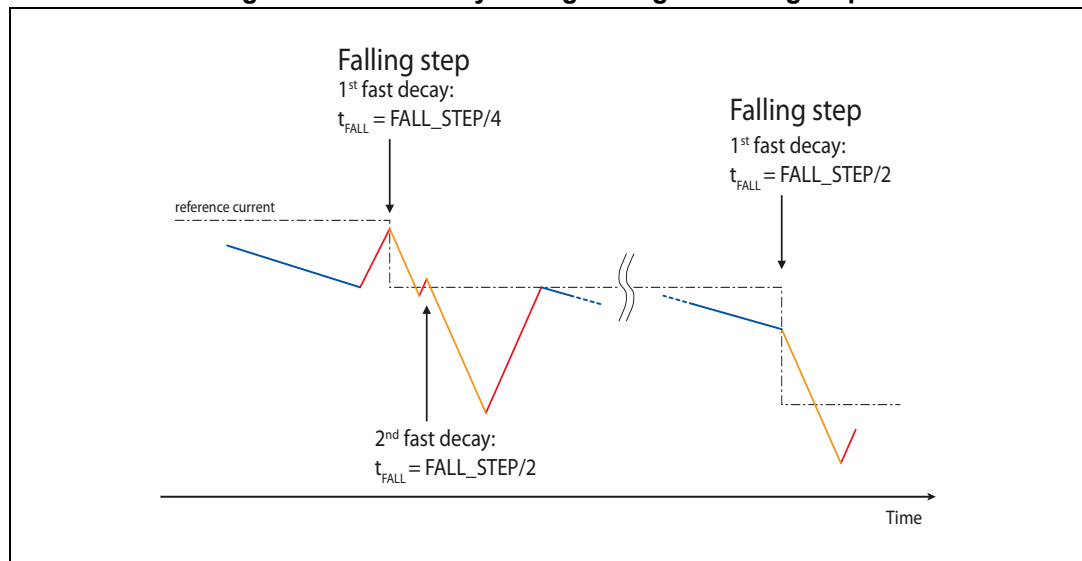
### 7.3 Auto-adjusted fast decay during the falling steps

When the target current is decreased by a microstep change (falling step), the device performs a fast decay in order to reach the new value as fast as possible. Anyway, exceeding the fast duration could cause a strong ripple on the step change. The L6474 automatically adjusts these fast decays reducing the current ripple.

At reset, the fast decay value ( $t_{FALL}$ ) is set to  $FALL\_STEP/4$  ( $T\_FAST$  register). The  $t_{FALL}$  value is doubled every time, within the same falling step, an extra fast decay is necessary to obtain an ON time greater than  $TON\_MIN$ . The maximum  $t_{FALL}$  value is equal to  $FALL\_STEP$ .

At the next falling step, the system uses the last  $t_{FALL}$  value of the previous falling step. Stopping the motor or reaching the current sinewave zero crossing causes the current control system to return to the reset state.

Figure 12. Fast decay tuning during the falling steps



## 7.4 Torque regulation (output current amplitude regulation)

The output current amplitude can be regulated in two ways: writing the TVAL register or varying the ADCIN voltage value.

The EN\_TQREG bit (CONFIG register) sets the torque regulation method. If this bit is high, ADC\_OUT prevalue is used to regulate output current amplitude (see [Section 9.1.8 on page 37](#)). Otherwise the internal analog to digital converter is at the user's disposal and the output current amplitude is managed by the TVAL register (see [Section 9.1.4 on page 34](#)).

The voltage applied to the ADCIN pin is sampled at  $f_s$  frequency and converted in an NADC bit digital signal. The analog to digital conversion result is available in the ADC\_OUT register.

## 8 Serial interface

The integrated 8-bit serial peripheral interface (SPI) is used for a synchronous serial communication between the host microprocessor (always master) and the L6474 (always slave).

The SPI uses chip select ( $\overline{CS}$ ), serial clock (CK), serial data input (SDI) and serial data output (SDO) pins. When  $\overline{CS}$  is high, the device is unselected and the SDO line is inactive (high-impedance).

The communication starts when  $\overline{CS}$  is forced low. The CK line is used for synchronization of data communication.

All commands and data bytes are shifted into the device through the SDI input, most significant bit first. The SDI is sampled on the rising edges of the CK.

All output data bytes are shifted out of the device through the SDO output, most significant bit first. The SDO is latched on the falling edges of the CK. When a return value from the device is not available, an all zero byte is sent.

After each byte transmission, the  $\overline{CS}$  input must be raised and be kept high for at least  $t_{disCS}$  in order to allow the device to decode the received command and put the return value into the shift register.

All timing requirements are shown in [Figure 13](#) (see respective [Section 3: Electrical characteristics on page 10](#) for values).

Multiple devices can be connected in a daisy chain configuration, as shown in [Figure 14](#).

**Figure 13. SPI timings diagram**

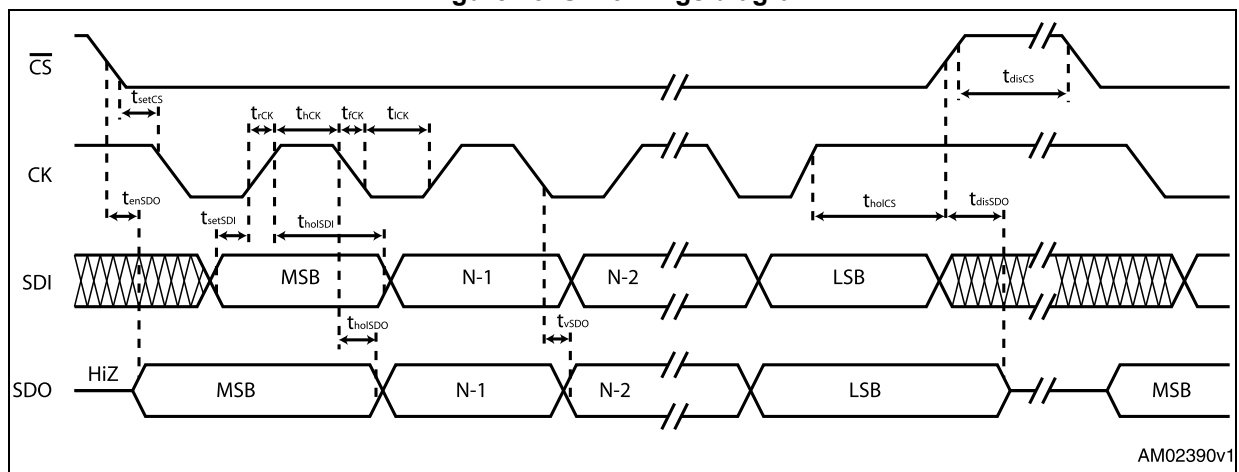
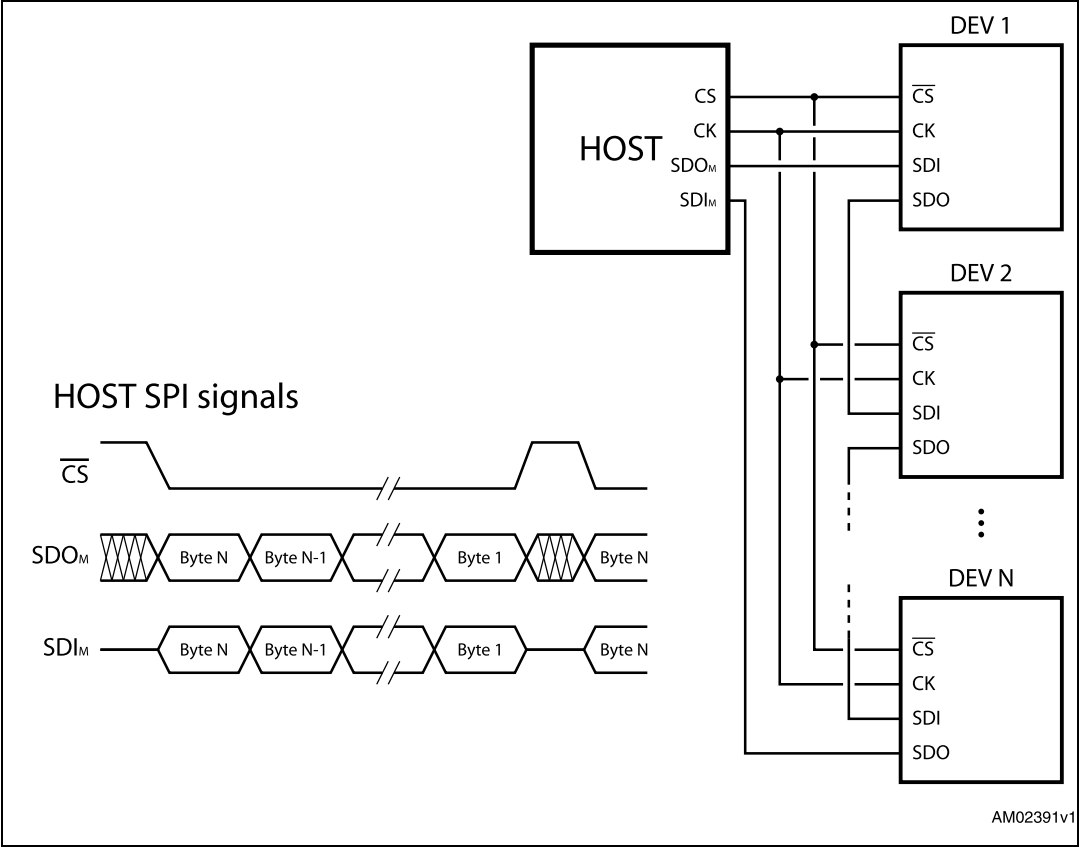


Figure 14. Daisy chain configuration





## 9 Programming manual

### 9.1 Registers and flags description

[Table 9](#) is a map of the user registers available (detailed description in respective paragraphs):

**Table 9. Register map**

| Address [Hex] | Register name | Register function         | Len. [bit] | Reset Hex         | Reset value                                                                                                                                                  | Remarks <sup>(1)</sup> |
|---------------|---------------|---------------------------|------------|-------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------|
| h01           | ABS_POS       | Current position          | 22         | 000000            | 0                                                                                                                                                            | R, WR                  |
| h02           | EL_POS        | Electrical position       | 9          | 000               | 0                                                                                                                                                            | R, WR                  |
| h03           | MARK          | Mark position             | 22         | 000000            | 0                                                                                                                                                            | R, WR                  |
| h04           | RESERVED      | Reserved address          | 24         |                   |                                                                                                                                                              |                        |
| h05           | RESERVED      | Reserved address          | 16         |                   |                                                                                                                                                              |                        |
| h06           | RESERVED      | Reserved address          | 16         |                   |                                                                                                                                                              |                        |
| h07           | RESERVED      | Reserved address          | 16         |                   |                                                                                                                                                              |                        |
| h08           | RESERVED      | Reserved address          | 16         |                   |                                                                                                                                                              |                        |
| h15           | RESERVED      | Reserved address          | 16         |                   |                                                                                                                                                              | R, WR                  |
| h09           | TVAL          | Reference current         | 7          | 29                | 1.3125 A                                                                                                                                                     | R, WR                  |
| h0A           | RESERVED      | Reserved address          | 8          |                   |                                                                                                                                                              |                        |
| h0B           | RESERVED      | Reserved address          | 8          |                   |                                                                                                                                                              |                        |
| h0C           | RESERVED      | Reserved address          | 8          |                   |                                                                                                                                                              |                        |
| h0D           | RESERVED      | Reserved address          | 16         |                   |                                                                                                                                                              |                        |
| h0E           | T_FAST        | Fast decay/fall step time | 8          | 19                | 1 $\mu$ s / 5 $\mu$ s                                                                                                                                        | R, WH                  |
| h0F           | TON_MIN       | Minimum ON time           | 7          | 29                | 20.5 $\mu$ s                                                                                                                                                 | R, WH                  |
| h10           | TOFF_MIN      | Minimum OFF time          | 7          | 29                | 20.5 $\mu$ s                                                                                                                                                 | R, WH                  |
| h11           | RESERVED      | Reserved address          | 8          |                   |                                                                                                                                                              |                        |
| h12           | ADC_OUT       | ADC output                | 5          | XX <sup>(2)</sup> |                                                                                                                                                              | R                      |
| h13           | OCD_TH        | OCD threshold             | 4          | 8                 | 3.38A                                                                                                                                                        | R, WR                  |
| h14           | RESERVED      | Reserved address          | 8          |                   |                                                                                                                                                              |                        |
| h16           | STEP_MODE     | Step mode                 | 8          | 7                 | 16 microsteps, no synch                                                                                                                                      | R, WH                  |
| h17           | ALARM_EN      | Alarms enables            | 8          | FF                | All alarms enabled                                                                                                                                           | R, WR                  |
| h18           | CONFIG        | IC configuration          | 16         | 2E88              | Internal oscillator, 2 MHz OSCOUT clock, supply voltage compensation disabled, overcurrent shutdown enabled, slew rate = 290 V/ $\mu$ s<br>TOFF = 40 $\mu$ s | R, WH                  |

Table 9. Register map (continued)

| Address [Hex] | Register name | Register function | Len. [bit] | Reset Hex           | Reset value                                | Remarks <sup>(1)</sup> |
|---------------|---------------|-------------------|------------|---------------------|--------------------------------------------|------------------------|
| h19           | STATUS        | Status            | 16         | XXXX <sup>(2)</sup> | High impedance state, UVLO/reset flag set. | R                      |
| h1A           | RESERVED      | Reserved address  |            |                     |                                            |                        |
| h1B           | RESERVED      | Reserved address  |            |                     |                                            |                        |

1. R: Readable, WH: writable only when outputs are in high impedance, WR: always writable.

2. According to startup conditions.

### 9.1.1 ABS\_POS

The ABS\_POS register contains the current motor absolute position in agreement to the selected step mode; the stored value unit is equal to the selected step mode (full, half, quarter, etc.). The value is in 2's complement format and it ranges from  $-2^{21}$  to  $+2^{21}-1$ .

At power-on the register is initialized to "0" (HOME position).

### 9.1.2 EL\_POS

The EL\_POS register contains the current electrical position of the motor. The two MSbits indicate the current step and the other bits indicate the current microstep (expressed in step/128) within the step.

Table 10. EL\_POS register

| Bit 8 | Bit 7 | Bit 6     | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|-------|-------|-----------|-------|-------|-------|-------|-------|-------|
| STEP  |       | MICROSTEP |       |       |       |       |       |       |

When the EL\_POS register is written by the user the new electrical position is instantly imposed. When the EL\_POS register is written its value must be masked in order to match with the step mode selected in the STEP\_MODE register in order to avoid a wrong microstep value generation (see [Section 9.1.10 on page 38](#)); otherwise the resulting microstep sequence is incorrect.

Any attempt to write the register when the outputs are enabled causes the command to be ignored and the NOTPERF\_CMD flag to rise (see [Section 9.1.13 on page 41](#)).

### 9.1.3 MARK

The MARK register contains an absolute position called MARK, according to the selected step mode; the stored value unit is equal to the selected step mode (full, half, quarter, etc.).

It is in 2's complement format and it ranges from  $-2^{21}$  to  $+2^{21}-1$ .

### 9.1.4 TVAL

The TVAL register contains the current value that is assigned to the torque regulation DAC.

The available range is from 31.25 mA to 4 A with a resolution of 31.25 mA, as shown in [Table 2 on page 8](#).

Table 11. Torque regulation register

| TVAL [6...0] |   |   |   |   |   |   | Output current amplitude |
|--------------|---|---|---|---|---|---|--------------------------|
| 0            | 0 | 0 | 0 | 0 | 0 | 0 | 31.25 mA                 |
| 0            | 0 | 0 | 0 | 0 | 0 | 1 | 62.5 mA                  |
| ⋮            | ⋮ | ⋮ | ⋮ | ⋮ | ⋮ | ⋮ | ⋮                        |
| 1            | 1 | 1 | 1 | 1 | 1 | 0 | 3.969 A                  |
| 1            | 1 | 1 | 1 | 1 | 1 | 1 | 4 A                      |

### 9.1.5 T\_FAST

The T\_FAST register contains the maximum fast decay time (TOFF\_FAST) and the maximum fall step time (FALL\_STEP) used by the current control system (see [Section 7.2 on page 28](#) and [Section 7.3 on page 29](#) for details):

Table 12. T\_FAST register

| Bit 7     | Bit 6 | Bit 5 | Bit 4 | Bit 3     | Bit 2 | Bit 1 | Bit 0 |
|-----------|-------|-------|-------|-----------|-------|-------|-------|
| TOFF_FAST |       |       |       | FAST_STEP |       |       |       |

The available range for both parameters is from 2  $\mu$ s to 32  $\mu$ s.

Table 13. Maximum fast decay times

| TOFF_FAST [3...0]<br>FAST_STEP[3...0] |   |   |   | Fast decay time |
|---------------------------------------|---|---|---|-----------------|
| 0                                     | 0 | 0 | 0 | 2 $\mu$ s       |
| 0                                     | 0 | 0 | 1 | 4 $\mu$ s       |
| ⋮                                     | ⋮ | ⋮ | ⋮ | ⋮               |
| 1                                     | 1 | 1 | 0 | 28 $\mu$ s      |
| 1                                     | 1 | 1 | 1 | 32 $\mu$ s      |

Any attempt to write to the register when the outputs are enabled causes the command to be ignored and the NOTPERF\_CMD to rise (see [Section 9.1.13 on page 41](#)).

### 9.1.6 TON\_MIN

The TON\_MIN register contains the minimum ON time value used by the current control system (see [Section 7.2](#)).

The available range for both parameters is from 0.5  $\mu$ s to 64  $\mu$ s.

Table 14. Minimum ON time

|          |          |          |          |          |          |          | Time         |
|----------|----------|----------|----------|----------|----------|----------|--------------|
| 0        | 0        | 0        | 0        | 0        | 0        | 0        | 0.5 $\mu$ s  |
| 0        | 0        | 0        | 0        | 0        | 0        | 1        | 1 $\mu$ s    |
| $\vdots$ | $\vdots$ | $\vdots$ | $\vdots$ | $\vdots$ | $\vdots$ | $\vdots$ | $\vdots$     |
| 1        | 1        | 1        | 1        | 1        | 1        | 0        | 63.5 $\mu$ s |
| 1        | 1        | 1        | 1        | 1        | 1        | 1        | 64 $\mu$ s   |

Any attempt to write to the register when the outputs are enabled causes the command to be ignored and the NOTPERF\_CMD to rise (see [Section 9.1.13 on page 41](#)).

### 9.1.7 TOFF\_MIN

The TOFF\_MIN register contains the minimum OFF time value used by the current control system (see [Section 7.1 on page 27](#) for details). This parameter imposes the OFF time of the current control system only if its value is greater than the TSW one.

The available range for both parameters is from 0.5  $\mu$ s to 64  $\mu$ s.

Table 15. Minimum OFF time

|          |          |          |          |          |          |          | Time         |
|----------|----------|----------|----------|----------|----------|----------|--------------|
| 0        | 0        | 0        | 0        | 0        | 0        | 0        | 0.5 $\mu$ s  |
| 0        | 0        | 0        | 0        | 0        | 0        | 1        | 1 $\mu$ s    |
| $\vdots$ | $\vdots$ | $\vdots$ | $\vdots$ | $\vdots$ | $\vdots$ | $\vdots$ | $\vdots$     |
| 1        | 1        | 1        | 1        | 1        | 1        | 0        | 63.5 $\mu$ s |
| 1        | 1        | 1        | 1        | 1        | 1        | 1        | 64 $\mu$ s   |

Any attempt to write to the register when the outputs are enabled causes the command to be ignored and the NOTPERF\_CMD to rise (see [Section 9.1.13](#)).

### 9.1.8 ADC\_OUT

The ADC\_OUT register contains the result of the analog to digital conversion of the ADCIN pin voltage.

Any attempt to write to the register causes the command to be ignored and the NOTPERF\_CMD flag to rise (see [Section 9.1.13 on page 41](#)).

**Table 16. ADC\_OUT value and torque regulation feature**

| VADCIN/ VREG | ADC_OUT [4...0] |   |   |   |   | Output current amplitude |
|--------------|-----------------|---|---|---|---|--------------------------|
| 0            | 0               | 0 | 0 | 0 | 0 | 125 mA                   |
| 1/32         | 0               | 0 | 0 | 0 | 1 | 250 mA                   |
| ⋮            | ⋮               | ⋮ | ⋮ | ⋮ | ⋮ | ⋮                        |
| 30/32        | 1               | 1 | 1 | 1 | 0 | 3.875 A                  |
| 31/32        | 1               | 1 | 1 | 1 | 1 | 4 A                      |

### 9.1.9 OCD\_TH

The OCD\_TH register contains the overcurrent threshold value (see [Section 6.9 on page 23](#) for details). The available range is from 375 mA to 6 A, steps of 375 mA as shown in [Table 17](#).

**Table 17. Overcurrent detection threshold**

| OCD_TH [3...0] |   |   |   | Overcurrent detection threshold |
|----------------|---|---|---|---------------------------------|
| 0              | 0 | 0 | 0 | 375 mA                          |
| 0              | 0 | 0 | 1 | 750 mA                          |
| ⋮              | ⋮ | ⋮ | ⋮ | ⋮                               |
| 1              | 1 | 1 | 0 | 5.625 A                         |
| 1              | 1 | 1 | 1 | 6 A                             |

### 9.1.10 STEP\_MODE

The STEP\_MODE register has the following structure:

**Table 18. STEP\_MODE register**

| Bit 7 | Bit 6    | Bit 5 | Bit 4 | Bit 3            | Bit 2    | Bit 1 | Bit 0 |
|-------|----------|-------|-------|------------------|----------|-------|-------|
| 1     | SYNC_SEL |       |       | 1 <sup>(1)</sup> | STEP_SEL |       |       |

1. When the register is written this bit should be set to 1.

The STEP\_SEL parameter selects one of five possible stepping modes:

**Table 19. Step mode selection**

| STEP_SEL[2...0] |   |   | Step mode      |
|-----------------|---|---|----------------|
| 0               | 0 | 0 | Full step      |
| 0               | 0 | 1 | Half step      |
| 0               | 1 | 0 | 1/4 microstep  |
| 0               | 1 | 1 | 1/8 microstep  |
| 1               | X | X | 1/16 microstep |

Every time the step mode is changed, the electrical position (i.e. the point of microstepping sinewave that is generated) is reset to the first microstep.

---

**Warning:** Every time STEP\_SEL is changed the value in ABS\_POS register loses meaning and should be reset.

---

Any attempt to write the register when the outputs are enabled causes the command to be ignored and the NOTPERF\_CMD flag to rise (see [Section 9.1.13 on page 41](#)).

The SYNC output provides a synchronization signal according to SYNC\_SEL parameter.

The synchronization signal is obtained starting from electrical position information (EL\_POS register) according to [Table 10 on page 34](#):

**Table 20. SYNC signal source**

| SYNC_SEL[2...0] |   |   | Source                |
|-----------------|---|---|-----------------------|
| 0               | 0 | 0 | EL_POS [7]            |
| 0               | 0 | 1 | EL_POS [6]            |
| 0               | 1 | 0 | EL_POS [5]            |
| 0               | 1 | 1 | EL_POS [4]            |
| 1               | 0 | 0 | EL_POS [3]            |
| 1               | 0 | 1 | UNUSED <sup>(1)</sup> |
| 1               | 1 | 0 | UNUSED <sup>(1)</sup> |
| 1               | 1 | 1 | UNUSED <sup>(1)</sup> |

1. When this value is selected the BUSY output is forced low.

### 9.1.11 ALARM\_EN

The ALARM\_EN register allows to select which alarm signals are used to generate the FLAG output. If the respective bit of the ALARM\_EN register is set high, the alarm condition forces the FLAG pin output down.

**Table 21. ALARM\_EN register**

| ALARM_EN bit | Alarm condition                  |
|--------------|----------------------------------|
| 0 (LSB)      | Overcurrent                      |
| 1            | Thermal shutdown                 |
| 2            | Thermal warning                  |
| 3            | Undervoltage                     |
| 4            | RESERVED                         |
| 5            | RESERVED                         |
| 6            | Switch turn-on event             |
| 7 (MSB)      | Wrong or not performable command |

### 9.1.12 CONFIG

The CONFIG register has the following structure:

**Table 22. CONFIG register**

| Bit 15 | Bit 14   | Bit 13   | Bit 12 | Bit 11  | Bit 10  | Bit 9  | Bit 8 |
|--------|----------|----------|--------|---------|---------|--------|-------|
| 0      | TOFF     |          |        |         |         | POW_SR |       |
| Bit 7  | Bit 6    | Bit 5    | Bit 4  | Bit 3   | Bit 2   | Bit 1  | Bit 0 |
| OC_SD  | RESERVED | EN_TQREG | 0      | EXT_CLK | OSC_SEL |        |       |

The OSC\_SEL and EXT\_CLK bits set the system clock source:

**Table 23. Oscillator management**

| EXT_CLK | OSC_SEL[2...0] |   |   | Clock source                                                     | OSCIN                     | OSCOUT                         |
|---------|----------------|---|---|------------------------------------------------------------------|---------------------------|--------------------------------|
| 0       | 0              | 0 | 0 | Internal oscillator: 16 MHz                                      | Unused                    | Unused                         |
| 0       | 0              | 0 | 1 |                                                                  |                           |                                |
| 0       | 0              | 1 | 0 |                                                                  |                           |                                |
| 0       | 0              | 1 | 1 |                                                                  |                           |                                |
| 1       | 0              | 0 | 0 | Internal oscillator: 16 MHz                                      | Unused                    | Supplies a 2 MHz clock         |
| 1       | 0              | 0 | 1 | Internal oscillator: 16 MHz                                      | Unused                    | Supplies a 4 MHz clock         |
| 1       | 0              | 1 | 0 | Internal oscillator: 16 MHz                                      | Unused                    | Supplies a 8 MHz clock         |
| 1       | 0              | 1 | 1 | Internal oscillator: 16 MHz                                      | Unused                    | Supplies a 16 MHz clock        |
| 0       | 1              | 0 | 0 | External crystal or resonator: 8 MHz                             | Crystal/resonator driving | Crystal/resonator driving      |
| 0       | 1              | 0 | 1 | External crystal or resonator: 16 MHz                            | Crystal/resonator driving | Crystal/resonator driving      |
| 0       | 1              | 1 | 0 | External crystal or resonator: 24 MHz                            | Crystal/resonator driving | Crystal/resonator driving      |
| 0       | 1              | 1 | 1 | External crystal or resonator: 32 MHz                            | Crystal/resonator driving | Crystal/resonator driving      |
| 1       | 1              | 0 | 0 | Ext. clock source: 8 MHz<br>(Crystal/resonator driver disabled)  | Clock source              | Supplies inverted OSCIN signal |
| 1       | 1              | 0 | 1 | Ext. clock source: 16 MHz<br>(Crystal/resonator driver disabled) | Clock source              | Supplies inverted OSCIN signal |
| 1       | 1              | 1 | 0 | Ext. clock source: 24 MHz<br>(Crystal/resonator driver disabled) | Clock source              | Supplies inverted OSCIN signal |
| 1       | 1              | 1 | 1 | Ext. clock source: 32 MHz<br>(Crystal/resonator driver disabled) | Clock source              | Supplies inverted OSCIN signal |

The OC\_SD bit sets whether or not an overcurrent event causes the bridges to turn off; the OCD flag in the status register is forced low anyway:

**Table 24. Overcurrent event**

| OC_SD | Overcurrent event        |
|-------|--------------------------|
| 1     | Bridges shut down        |
| 0     | Bridges do not shut down |

The POW\_SR bits set the slew rate value of power bridge output:



Table 25. Programmable power bridge output slew rate values

| POW_SR [1...0] |   | Output slew rate (1) [V/μs] <sup>(1)</sup> |
|----------------|---|--------------------------------------------|
| 0              | 0 | 320                                        |
| 0              | 1 | 75                                         |
| 1              | 0 | 110                                        |
| 1              | 1 | 260                                        |

1. See S<sub>Rout\_r</sub> and S<sub>Rout\_f</sub> parameters in [Table 5: Electrical characteristics on page 10](#) for details.

The TQREG bit sets if the torque regulation (see [Section 7.4 on page 30](#)) is performed through the ADCIN voltage (external) or TVAL register (internal):

Table 26. External torque regulation enable

| TQREG | External torque regulation enable |
|-------|-----------------------------------|
| 0     | Internal registers                |
| 1     | ADC input                         |

The TOFF time is used by current control system. If its value is lower than the TOFF\_MIN one, the OFF time is equal to TOFF\_MIN.

Table 27. OFF time

| TOFF [4...0] |   |   |   |   | OFF time |
|--------------|---|---|---|---|----------|
| 0            | 0 | 0 | 0 | 0 | 4 μs     |
| 0            | 0 | 0 | 0 | 1 | 4 μs     |
| 0            | 0 | 0 | 1 | 0 | 8 μs     |
| ⋮            | ⋮ | ⋮ | ⋮ | ⋮ | ⋮        |
| 1            | 1 | 1 | 1 | 1 | 124 μs   |

Any attempt to write the CONFIG register when the outputs are enabled causes the command to be ignored and the NOTPERF\_CMD flag to rise (see [Section 9.1.13](#)).

### 9.1.13 STATUS

Table 28. STATUS register

| Bit 15      | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8     |
|-------------|--------|--------|--------|--------|--------|-------|-----------|
| 1           | 1      | 1      | OCD    | TH_SD  | TH_WRN | UVLO  | WRONG_CMD |
| Bit 7       | Bit 6  | Bit 5  | Bit 4  | Bit 3  | Bit 2  | Bit 1 | Bit 0     |
| NOTPERF_CMD | 0      | 0      | DIR    | 0      | 0      | 1     | HiZ       |

When HiZ flag is high, it indicates that the bridges are in high impedance state. Enable command makes the device exit from High Z state unless error flags forcing a High Z state are active.

The UVLO flag is active low and is set by an undervoltage lockout or reset events (power-up included). The TH\_WRN, TH\_SD, OCD flags are active low and indicate, respectively, thermal warning, thermal shutdown and overcurrent detection events.

The NOTPERF\_CMD and WRONG\_CMD flags are active high and indicate, respectively, that the command received by SPI can't be performed or does not exist at all.

The UVLO, TH\_WRN, TH\_SD, OCD, NOTPERF\_CMD and WRONG\_CMD flags are latched: when the respective conditions make them active (low or high), they remain in that state until a GetStatus command is sent to the IC.

The DIR bit indicates the current motor direction:

**Table 29. STATUS register DIR bit**

| DIR | Motor direction |
|-----|-----------------|
| 1   | Forward         |
| 0   | Reverse         |

Any attempt to write to the register causes the command to be ignored and the NOTPERF\_CMD to rise (see [Section 9.1.13](#)).

## 9.2 Application commands

The commands summary is given in [Table 30](#).

**Table 30. Application commands**

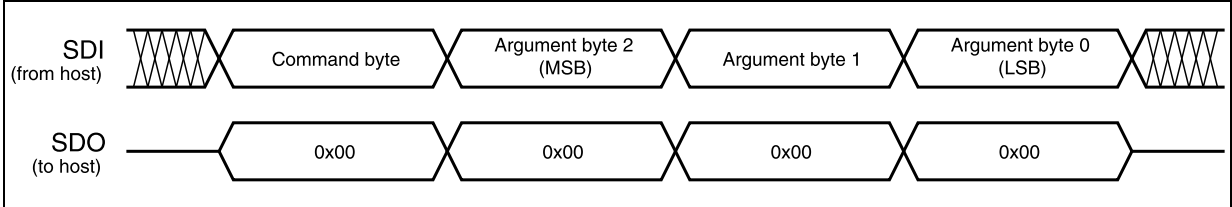
| Command Mnemonic      | Command binary code |         |     |         |     | Action                                                |
|-----------------------|---------------------|---------|-----|---------|-----|-------------------------------------------------------|
|                       | [7...5]             | [4]     | [3] | [2...1] | [0] |                                                       |
| NOP                   | 000                 | 0       | 0   | 00      | 0   | Nothing                                               |
| SetParam(PARAM,VALUE) | 000                 | [PARAM] |     |         |     | Writes VALUE in PARAM register                        |
| Enable                | 101                 | 1       | 1   | 00      | 0   | Enable the power stage                                |
| Disable               | 101                 | 0       | 1   | 00      | 0   | Puts the bridges in High Impedance status immediately |
| GetStatus             | 110                 | 1       | 0   | 00      | 0   | Returns the status register value                     |
| RESERVED              | 111                 | 0       | 1   | 01      | 1   | RESERVED COMMAND                                      |
| RESERVED              | 111                 | 1       | 1   | 00      | 0   | RESERVED COMMAND                                      |

### 9.2.1 Command management

The host microcontroller can control motor motion and configure the L6474 through a complete set of commands.

All commands are composed of a single byte. After the command byte, some bytes of arguments should be needed (see [Figure 15](#)). Argument length can vary from 1 to 3 bytes.

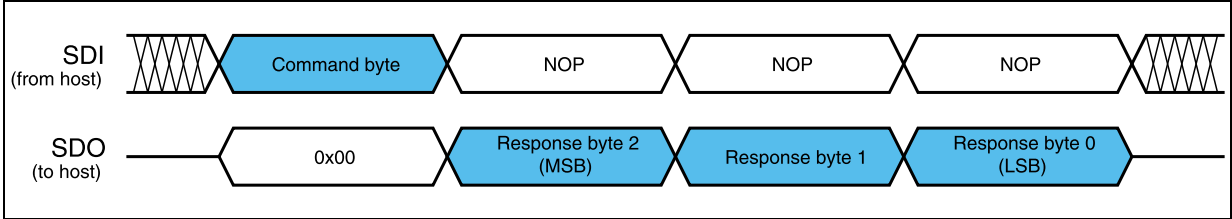
**Figure 15. Command with three-byte argument**



By default, the device returns an all zeroes response for any received byte, the only exceptions are GetParam and GetStatus commands. When one of these commands is received, the following response bytes represent the related register value (see [Figure 16](#)).

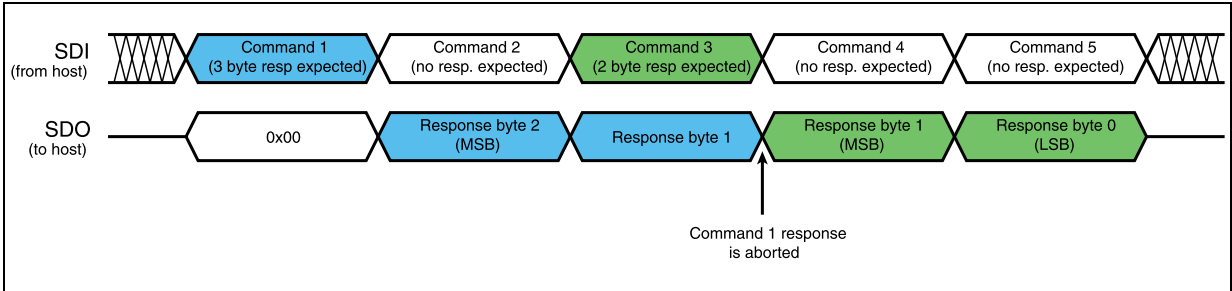
Response length can vary from 1 to 3 bytes.

**Figure 16. Command with three-byte response**



During response transmission, new commands can be sent. If a command requiring a response is sent before the previous response is completed, the response transmission is aborted and the new response is loaded into the output communication buffer (see [Figure 17](#)).

**Figure 17. Command response aborted**



When a byte that does not correspond to a command is sent to the IC it is ignored and the WRONG\_CMD flag in the STATUS register is raised (see [Section 9.1.13](#)).

## 9.2.2 NOP

Table 31. NOP command structure

| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |           |
|-------|-------|-------|-------|-------|-------|-------|-------|-----------|
| 0     | 0     | 0     | 0     | 0     | 0     | 0     | 0     | From host |

Nothing is performed.

## 9.2.3 SetParam (PARAM, VALUE)

Table 32. SetParam command structure

| Bit 7                    | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |           |
|--------------------------|-------|-------|-------|-------|-------|-------|-------|-----------|
| 0                        | 0     | 0     | PARAM |       |       |       |       | From host |
| VALUE Byte 2 (if needed) |       |       |       |       |       |       |       |           |
| VALUE Byte 1 (if needed) |       |       |       |       |       |       |       |           |
| VALUE Byte 0             |       |       |       |       |       |       |       |           |

The SetParam command sets the PARAM register value equal to VALUE; PARAM is the respective register address listed in [Table 16 on page 37](#).

The command should be followed by the new register VALUE (most significant byte first). The number of bytes composing the VALUE argument depends on the length of the target register (see [Table 16](#)).

Some registers cannot be written (see [Table 16](#)); any attempt to write one of those registers causes the command to be ignored and the WRONG\_CMD flag to rise at the end of command byte, the same is true when an unknown command code is sent (see [Section 9.1.13 on page 41](#)).

Some registers can only be written in particular conditions (see [Table 16](#)); any attempt to write one of those registers when the conditions are not satisfied causes the command to be ignored and the NOTPERF\_CMD flag to rise at the end of last argument byte (see [Section 9.1.13](#)).

Any attempt to set an inexistent register (wrong address value) causes the command to be ignored and the WRONG\_CMD flag to rise at the end of command byte, the same is true when an unknown command code is sent.

## 9.2.4 GetParam (PARAM)

**Table 33. GetParam command structure**

| Bit 7                  | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |           |
|------------------------|-------|-------|-------|-------|-------|-------|-------|-----------|
| 0                      | 0     | 1     | PARAM |       |       |       |       | From host |
| ANS Byte 2 (if needed) |       |       |       |       |       |       |       | To host   |
| ANS Byte 1 (if needed) |       |       |       |       |       |       |       | To host   |
| ANS Byte 0             |       |       |       |       |       |       |       | To host   |

This command reads the current PARAM register value; PARAM is the respective register address listed in [Table 16 on page 37](#).

The command response is the current value of the register (most significant byte first). The number of bytes composing the command response depends on the length of the target register (see [Table 16](#)).

The returned value is the register one at the moment of GetParam command decoding. If register values change after this moment the response is not accordingly updated.

All registers can be read anytime.

Any attempt to read an inexistent register (wrong address value) causes the command to be ignored and the WRONG\_CMD flag to rise at the end of command byte, the same is true when an unknown command code is sent.

## 9.2.5 Enable

**Table 34. HardStop command structure**

| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |           |
|-------|-------|-------|-------|-------|-------|-------|-------|-----------|
| 1     | 0     | 1     | 1     | 1     | 0     | 0     | 0     | From host |

The Enable command turns on the power stage of the device.

When the motor is in high-impedance state, an Enable command forces the bridges to exit from high impedance state.

This command can be given anytime and is immediately executed.

## 9.2.6 Disable

**Table 35. Disable command structure**

| Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |           |
|-------|-------|-------|-------|-------|-------|-------|-------|-----------|
| 1     | 0     | 1     | 0     | 1     | 0     | 0     | 0     | From host |

The Disable command immediately disables the power bridges (high-impedance state) and raises the HiZ flag.

This command can be given anytime and is immediately executed.

## 9.2.7 GetStatus

**Table 36. GetStatus command structure**

| Bit 7         | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |           |
|---------------|-------|-------|-------|-------|-------|-------|-------|-----------|
| 1             | 1     | 0     | 1     | 0     | 0     | 0     | 0     | From host |
| STATUS MSByte |       |       |       |       |       |       |       | To host   |
| STATUS LSByte |       |       |       |       |       |       |       | To host   |

The GetStatus command returns the Status register value. The GetStatus command resets the STATUS register warning flags. The command forces the system to exit from any error state. The GetStatus command DOES NOT reset the HiZ flag.

## 10 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

10.1 HTSSOP28 package information

Figure 18. HTSSOP28 package outline

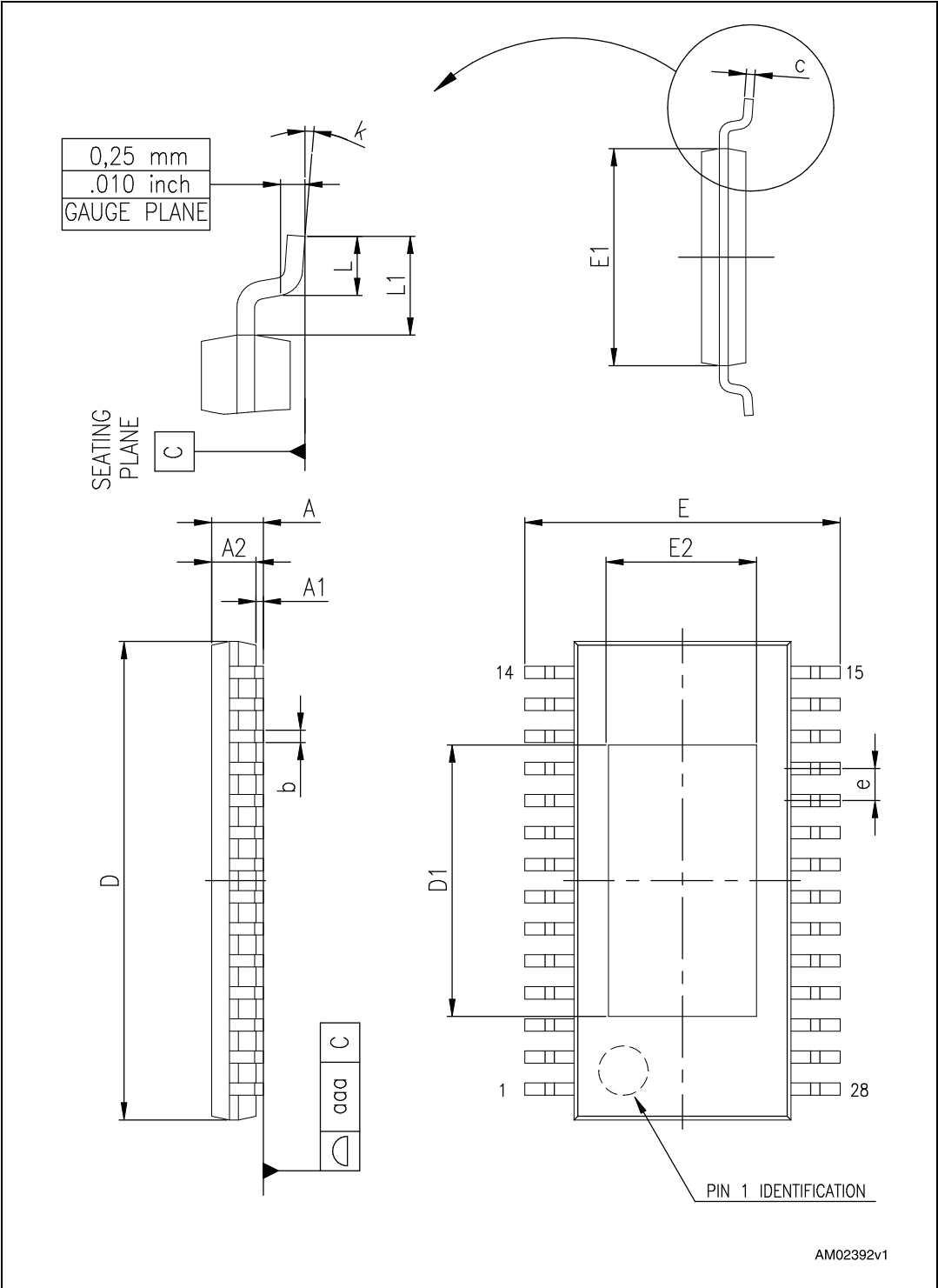




Table 37. HTSSOP28 package mechanical data

| Symbol            | Dimensions (mm) |      |      |
|-------------------|-----------------|------|------|
|                   | Min.            | Typ. | Max. |
| A                 |                 |      | 1.2  |
| A1                |                 |      | 0.15 |
| A2                | 0.8             | 1.0  | 1.05 |
| b                 | 0.19            |      | 0.3  |
| c                 | 0.09            |      | 0.2  |
| D <sup>(1)</sup>  | 9.6             | 9.7  | 9.8  |
| D1                |                 | 5.5  |      |
| E                 | 6.2             | 6.4  | 6.6  |
| E1 <sup>(2)</sup> | 4.3             | 4.4  | 4.5  |
| E2                |                 | 2.8  |      |
| e                 |                 | 0.65 |      |
| L                 | 0.45            | 0.6  | 0.75 |
| L1                |                 | 1.0  |      |
| K                 | 0°              |      | 8°   |
| aaa               |                 | 0.1  |      |

1. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusions or gate burrs do not exceed 0.15 mm per side.
2. Dimension "E1" does not include interlead flash or protrusions. Interlead flash or protrusions do not exceed 0.25 mm per side.

## 10.2 POWERSO36 package information

**Figure 19. POWERSO36 package outline**

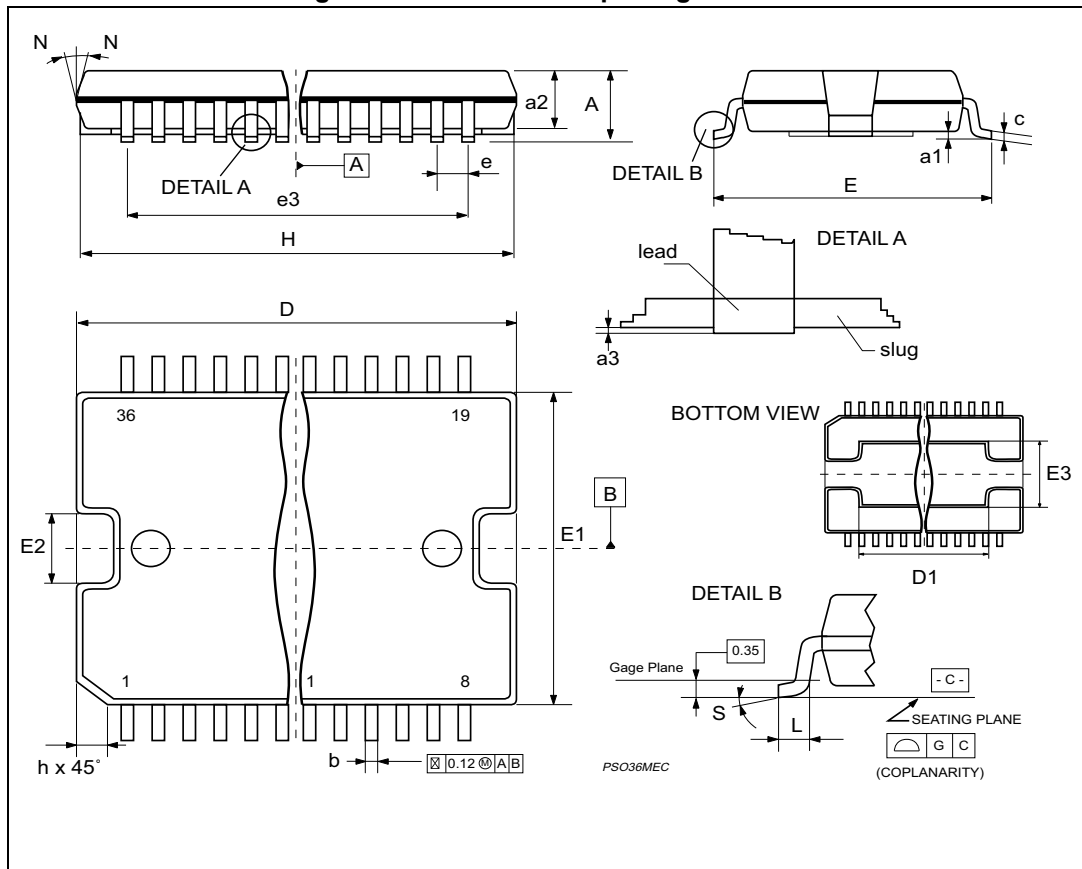


Table 38. POWERSO36 package mechanical data

| Symbol | Dimensions (mm) |       |       | Dimensions (inch) |       |        |
|--------|-----------------|-------|-------|-------------------|-------|--------|
|        | Min.            | Typ.  | Max.  | Min.              | Typ.  | Max.   |
| A      |                 |       | 3.60  |                   |       | 0.1417 |
| a1     | 0.10            |       | 0.30  | 0.003             |       | 0.0118 |
| a2     |                 |       | 3.30  |                   |       | 0.1299 |
| a3     | 0               |       | 0.10  | 0                 |       | 0.0039 |
| b      | 0.22            |       | 0.38  | 0.008             |       | 0.0150 |
| c      | 0.23            |       | 0.32  | 0.009             |       | 0.0126 |
| D      | 15.80           |       | 16.00 | 0.622             |       | 0.6299 |
| D1     | 9.40            |       | 9.80  | 0.370             |       | 0.3858 |
| E      | 13.90           |       | 14.50 | 0.547             |       | 0.5709 |
| E1     | 10.90           |       | 11.10 | 0.429             |       | 0.4370 |
| E2     |                 |       | 2.90  |                   |       | 0.1142 |
| E3     | 5.8             |       | 6.2   | 0.228             |       | 0.2441 |
| e      |                 | 0.65  |       |                   | 0.025 |        |
| e3     |                 | 11.05 |       |                   | 0.435 |        |
| G      | 0               |       | 0.10  | 0.000             |       | 0.0039 |
| H      | 15.50           |       | 15.90 | 0.610             |       | 0.6260 |
| h      |                 |       | 1.10  |                   |       | 0.0433 |
| L      | 0.80            |       | 1.10  | 0.031             |       | 0.0433 |
| N      |                 |       | 10°   |                   |       | 10°    |
| S      | 0°              |       | 8°    | 0°                |       | 8°     |

# 11 Revision history

**Table 39. Document revision history**

| Date        | Revision | Changes                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|-------------|----------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 02-Dec-2011 | 1        | Initial release.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| 22-Dec-2011 | 2        | Deleted previous chapter 6.4.1 Automatic full-step mode.<br>Minor text changes.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
| 20-Dec-2012 | 3        | Changed $T_{OP}$ value and $P_{tot}$ value in <a href="#">Table 2</a> .<br>Removed $T_j$ parameter in <a href="#">Table 3</a> .<br>Added typical values to <a href="#">Table 4</a> .<br>Updated HTSSOP28 mechanical data.<br>Minor text changes.                                                                                                                                                                                                                                                                                                                                           |
| 18-Mar-2015 | 5        | Removed “easySPIN” from the main title <a href="#">on page 1</a> .<br>Updated <a href="#">Figure 2 on page 15</a> (renamed pin label 22).<br>Updated <a href="#">Figure 3 on page 15</a> (renamed pin labels 7 and 29).<br>Updated <a href="#">Table 6 on page 16</a> (added label HTSSOP and POWERSO column).<br>Reformatted <a href="#">Section 10 on page 47</a> (updated/added titles and headers, reformatted order of <a href="#">Figure 18</a> and <a href="#">Table 37</a> , <a href="#">Figure 19</a> and <a href="#">Table 38</a> ).<br>Minor modifications throughout document. |

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